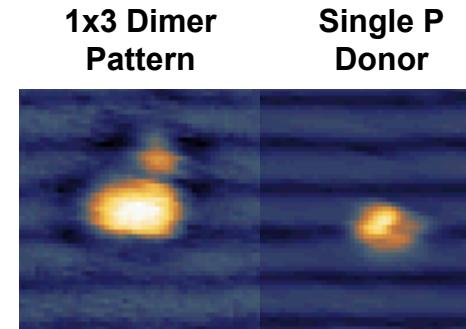
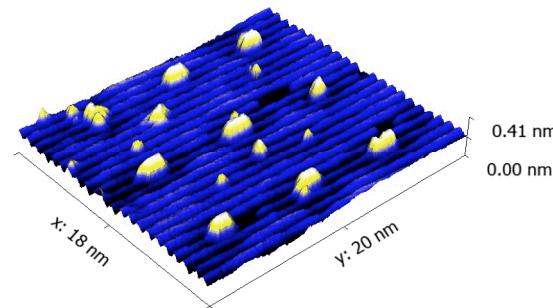
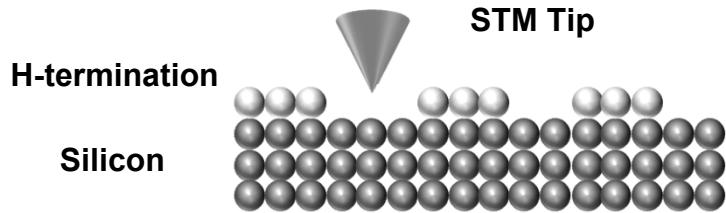


Exceptional service in the national interest



Atomically Precise Single Donor Placement by STM Lithography

J. Koepke (jkoepke@sandia.gov), D. Scrymgeour, R.J. Simonson, M. Marshall, D. Ward, R. Muller, P. Schultz, A. Baczewski, M. S. Carroll, S. Misra, E. Bussmann

Sandia National Labs, Albuquerque, New Mexico, USA

2016 CINT User Meeting

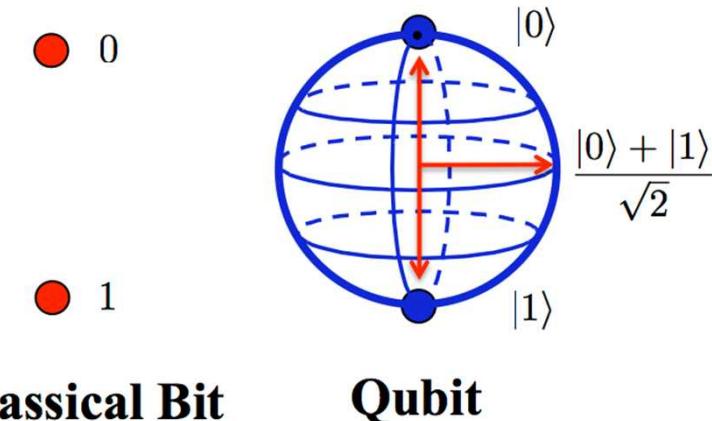


Sandia National Laboratories is a multi-mission laboratory managed and operated by Sandia Corporation, a wholly owned subsidiary of Lockheed Martin Corporation, for the U.S. Department of Energy's National Nuclear Security Administration under contract DE-AC04-94AL85000. SAND NO. 2011-XXXXP

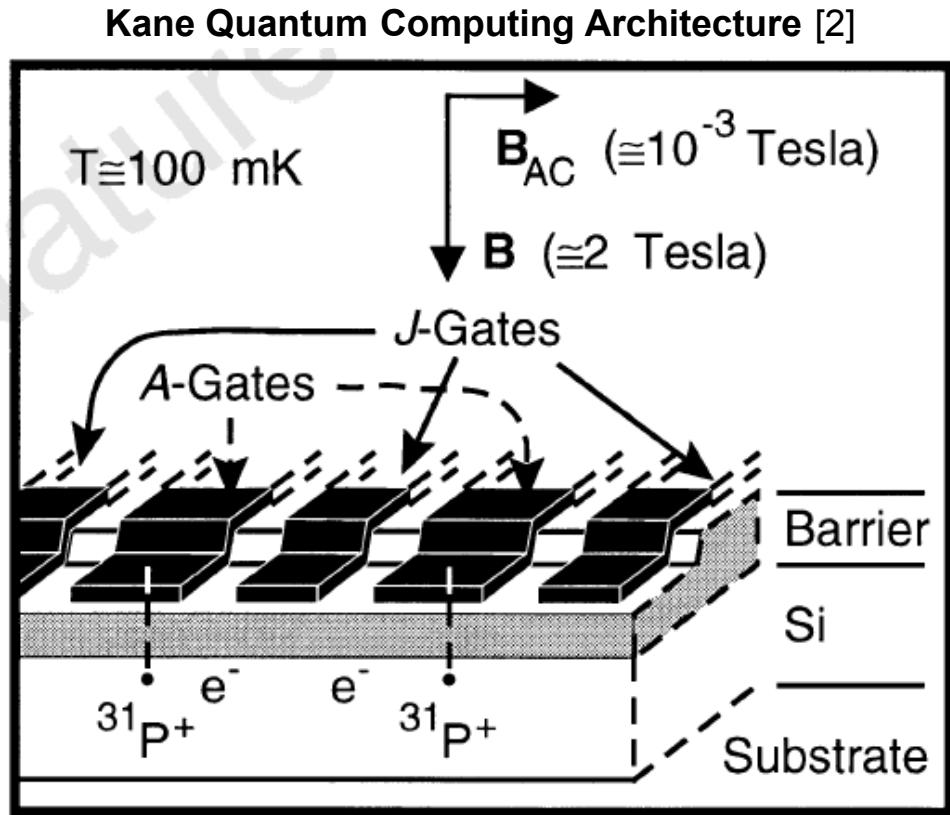
Overview/Motivation

- Motivation for Single P Donors in Si
- Donor Placement by STM Hydrogen Lithography
- Limitations to Donor Placement Yield
- Lithographic Arrays – Improving Target Pattern Yield
- Chemistry of P Donor Incorporation – Comparison of Experiment with Simulations

Single Donors in Si for Quantum Bits



Classical Bit vs. Quantum Bit [1]



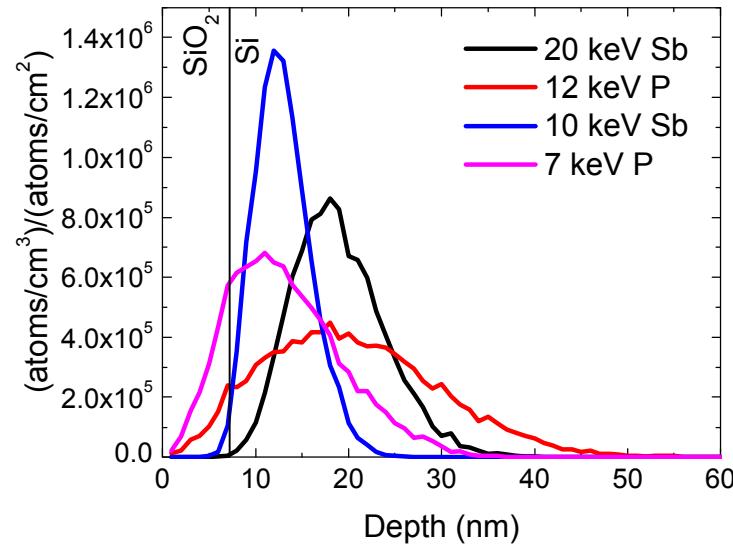
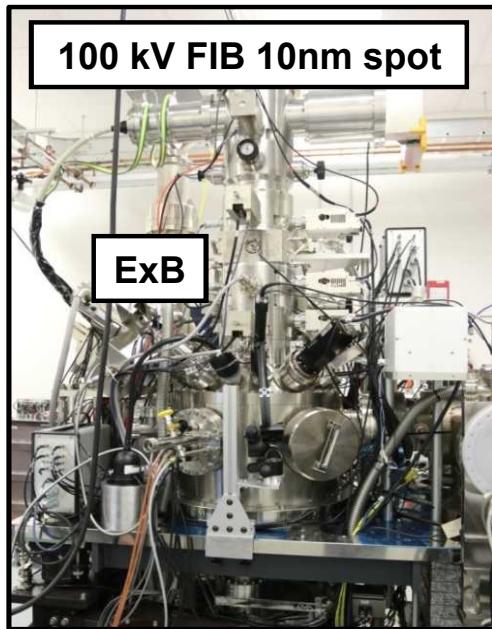
- Si environment allow leverage of vast existing fabrication capability
 - Si substrate shields qubit from spin and charge: “semiconductor vacuum” [2]
- P Donors in Si have very long spin coherence times [3]
 - ^{31}P nuclear spin coherence time $> 30 \text{ s}$
 - e^- spin coherence time $> 0.5 \text{ s}$

[1] http://qoqms.phys.strath.ac.uk/research_qc.html [2] Kane, *Nature*, **393** (1998);

[3] Steger, *Science*, **336** (2012); [4] Muhonen, *Nat. Nano.*, **9** (2014)

Routes to Single Donors in Si

Ion Implantation

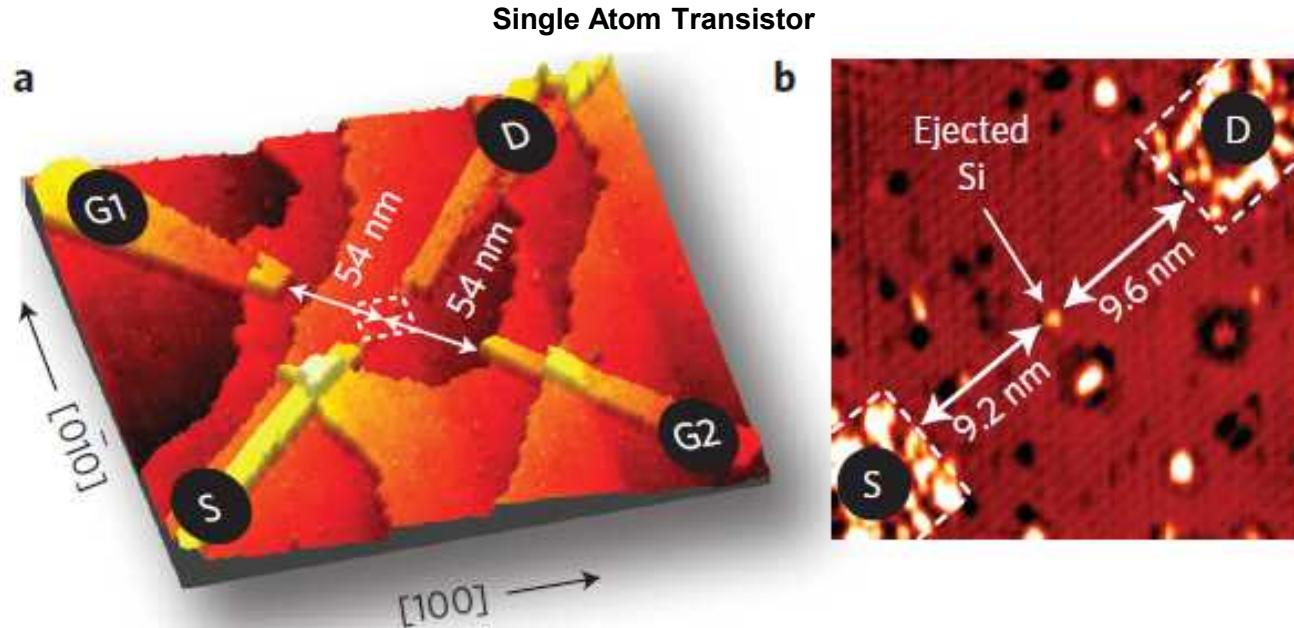


Provided courtesy of Bielejec (Sandia National Laboratories)

- Straggle: Significant uncertainty in donor placement

Routes to Single Donors in Si

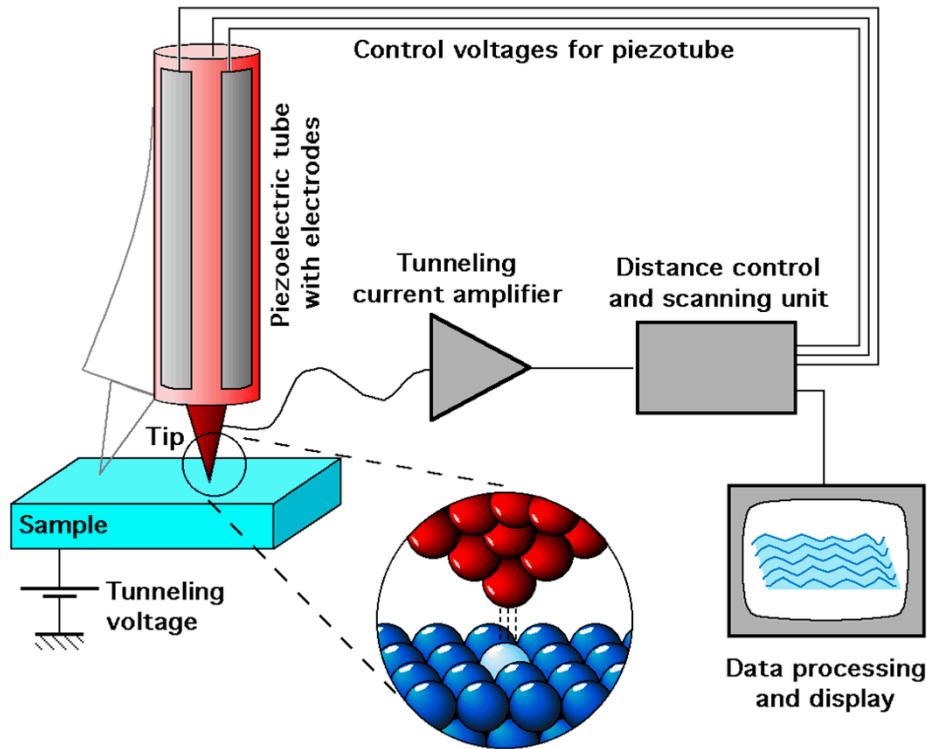
Atomically Precise Donor Placement



- Simmons' group (UNSW) has demonstrated atomically precise donor placement for device fabrication

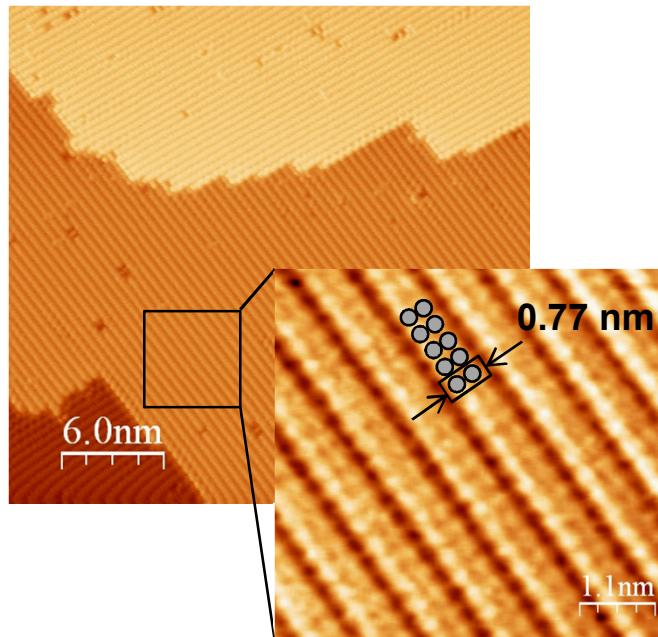
Scanning Tunneling Microscopy

STM Schematic



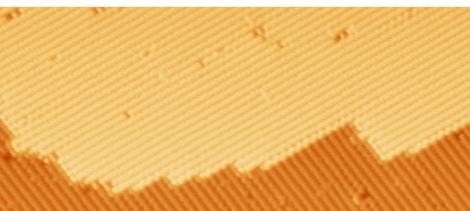
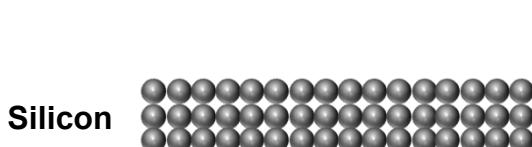
By Michael Schmid - Michael Schmid, TU Wien; adapted from the IAP/TU Wien STM Gallery, CC BY-SA 2.0 at, <https://commons.wikimedia.org/w/index.php?curid=180388>

Si(100) – 2×1 Surface

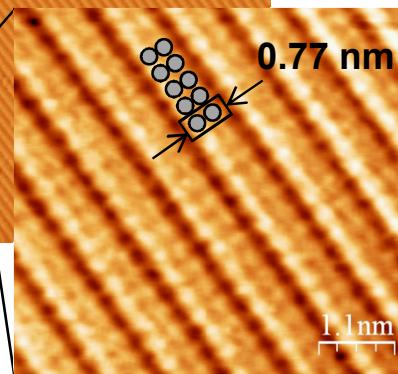


STM Hydrogen Lithography

Si(100) – 2×1:H Surface



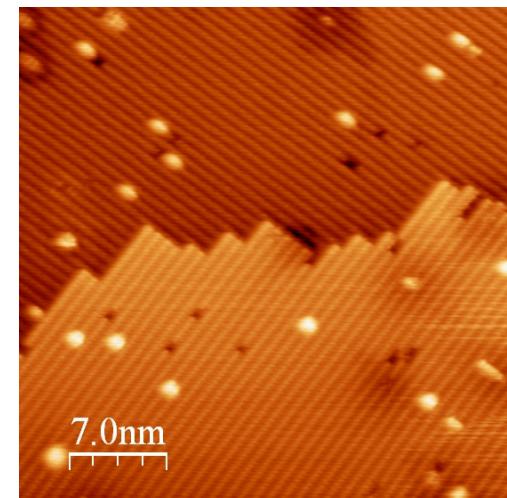
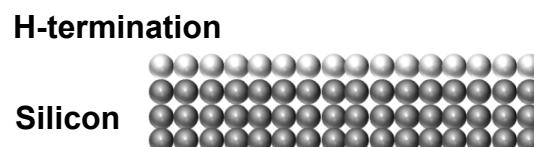
6.0 nm



1.1 nm

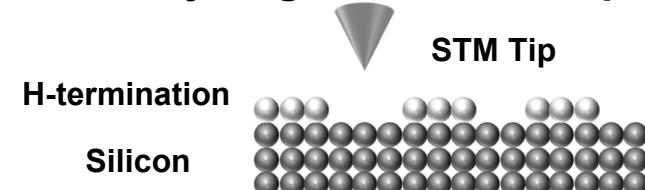
0.77 nm

Si(100) – 2×1:H Surface

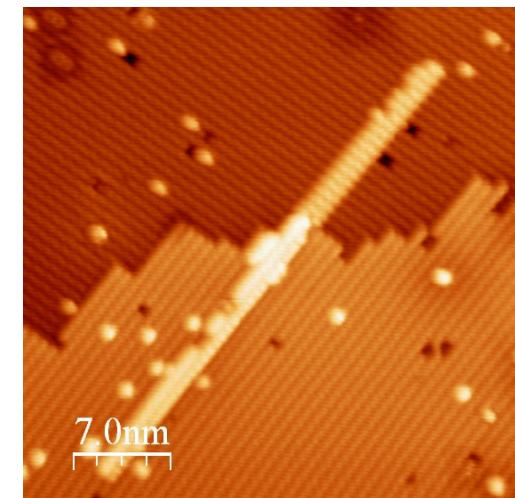


Dark spots are missing Si atoms.
Bright spots are missing H atoms

Remove Hydrogen with STM Tip



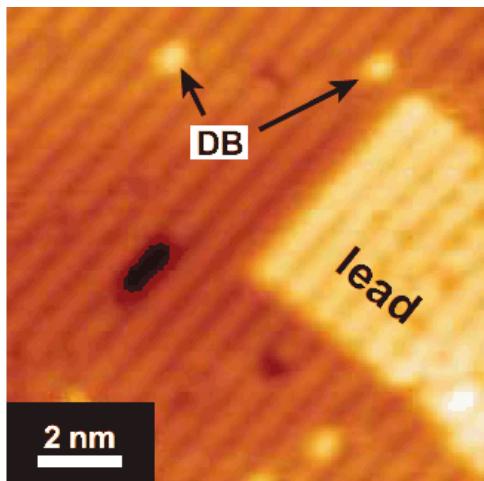
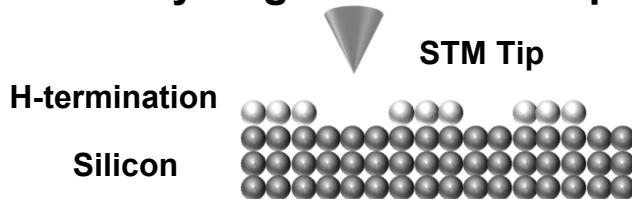
STM Tip



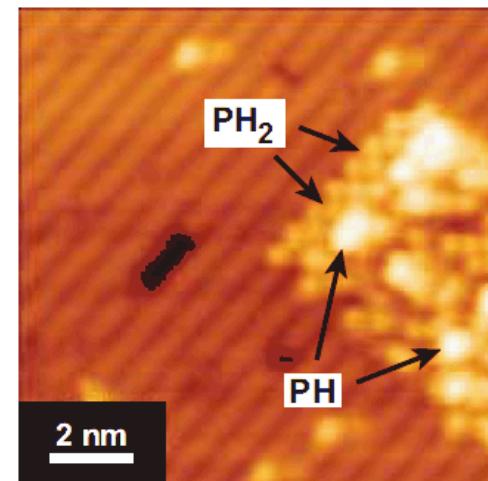
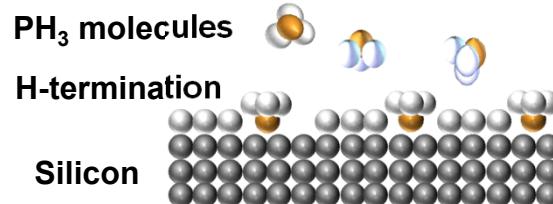
Can selectively remove H from the Si(100) – 2×1:H Surface using the STM tip 7

Donor Placement by STM Hydrogen Litho

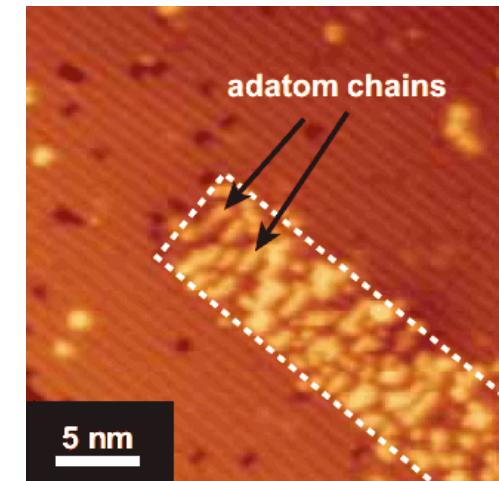
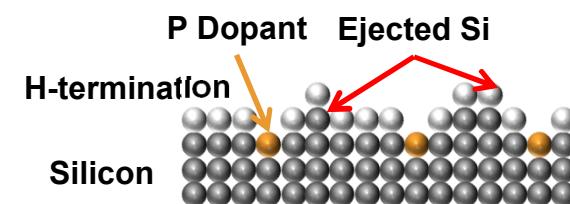
Remove Hydrogen with STM Tip



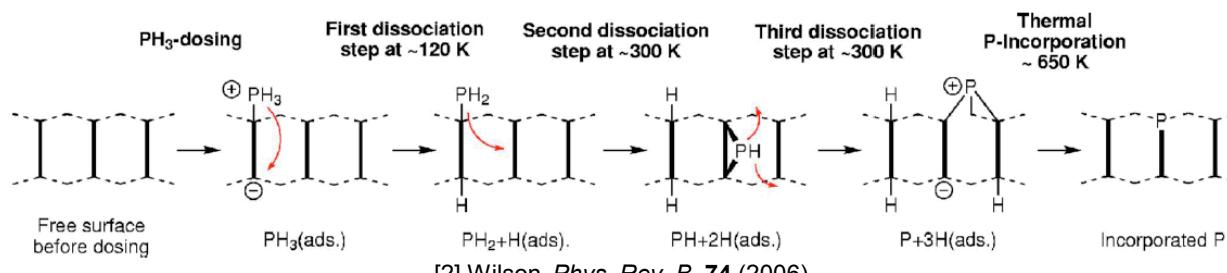
Dose sample with PH₃



Incorporate P Dopants



[1] Fuechsle, Ph.D. Dissertation (2011)

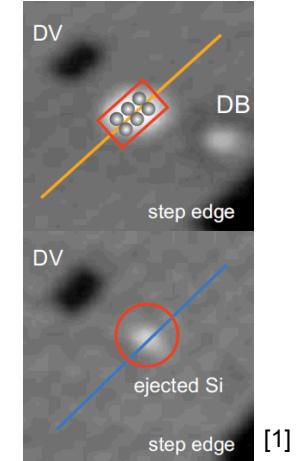
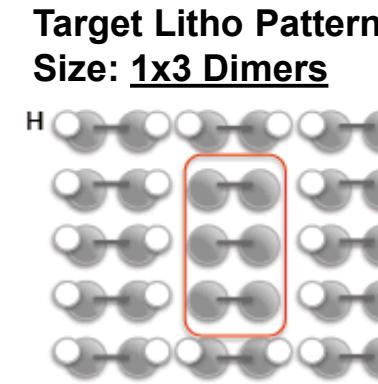


Substitutional incorporation of P donors from PH₃ is a thermally activated process 8

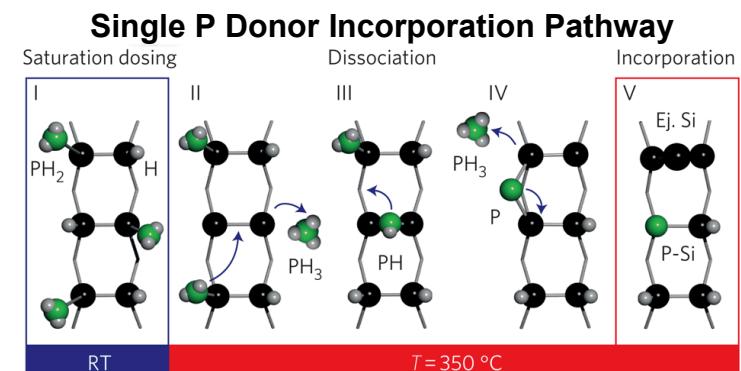
Factors Limiting Single Donor Placement Yield

Single Donor Yield = Litho Yield \times Chemistry Process Yield

- STM Lithographic Pattern Size
 - Highest reported *single* donor yield for 1x3 dimer lithography patterns [1].



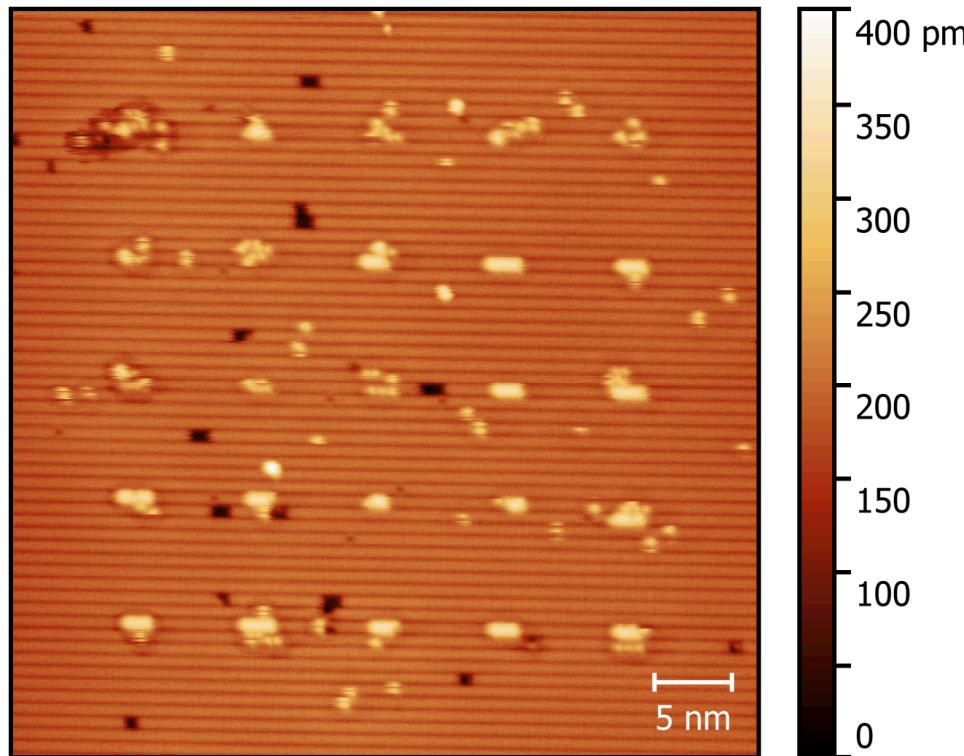
- Chemical Pathway
 - Reported 70% yield for single donors in 1x3 dimer patterns [1]



[2] Fuechsle, *Nat. Nano.*, 7 (2012)

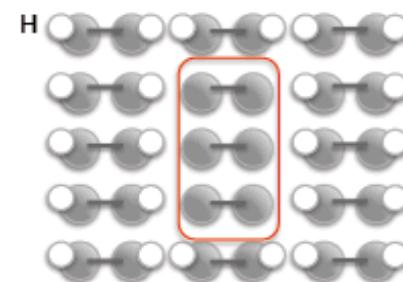
[1] Fuechsle, *Ph.D. Dissertation* (2011)

Lithography at Few Atom Limit



Only 20% of Litho Sites Single Row

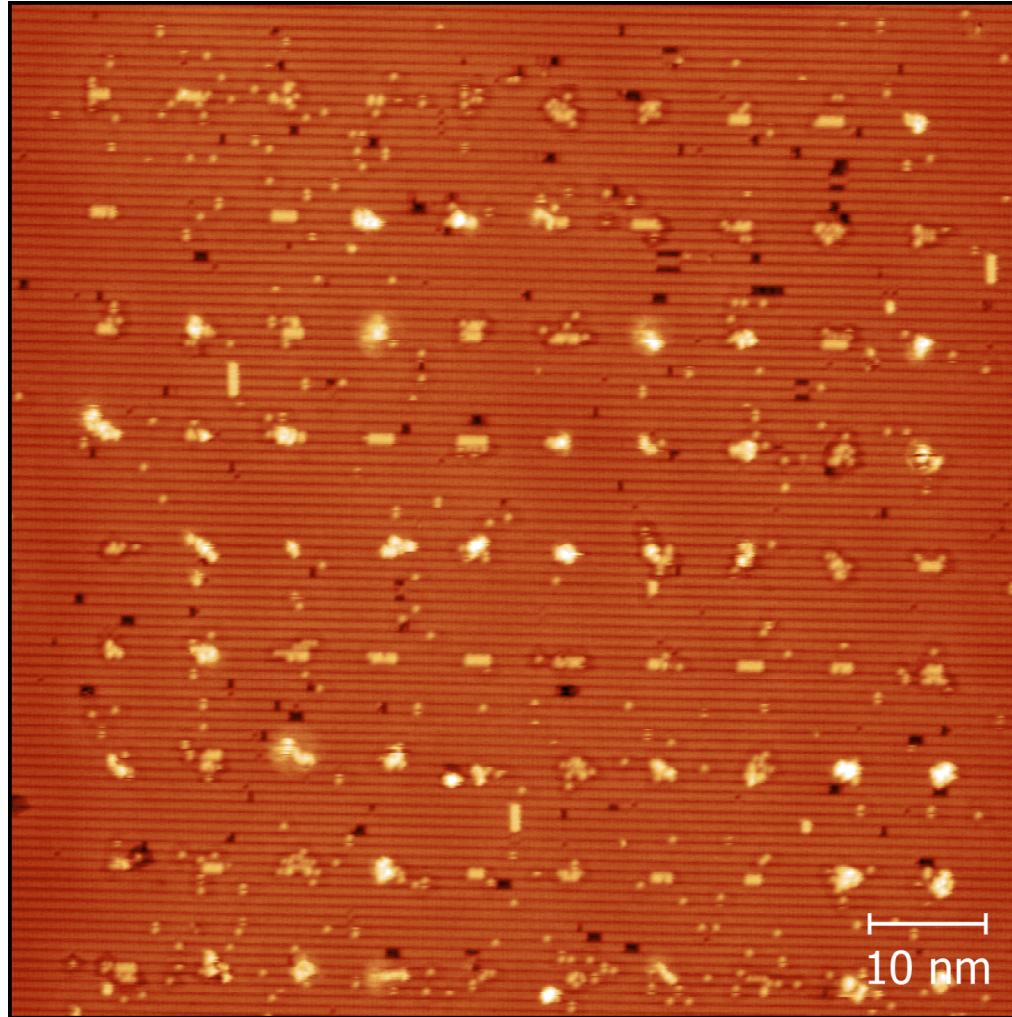
**Target Litho Array
Element: 1x3 Dimers**



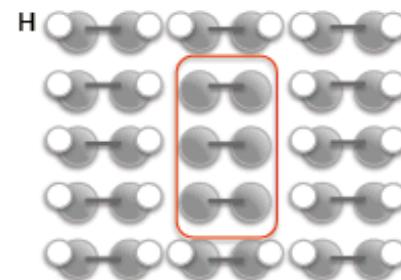
- Examine lithography statistics
- Factors affecting litho yield:
 - STM tip sharpness & stability
 - Litho Process Parameters

Limitations to Lithography at Few Atom Limit

Effect of Tip Instability



**Target Litho Array
Element: 1x3 Dimers**

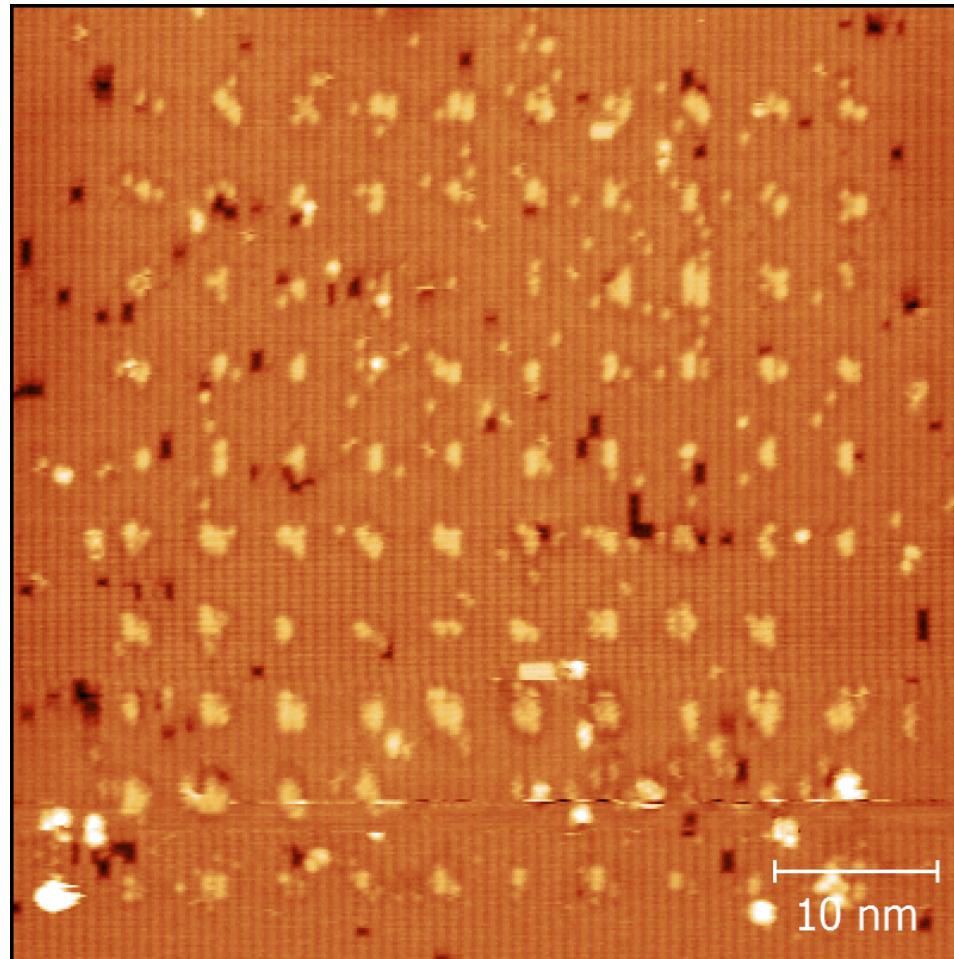


Unstable tips: (1) drop material during patterning
(2) give disordered lithographic patterns

Limitations to Lithography at Few Atom Limit

Effect of Tip Alignment to Dimer Rows

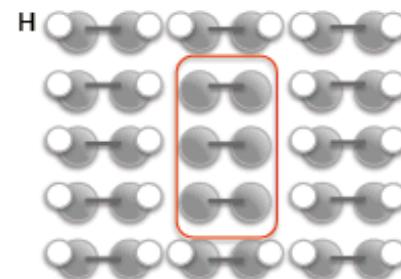
Litho Sites Intentionally Rotated 45° from Alignment with Dimer Rows



Only 10% of Litho Sites Single Row

Data collected by R. Butera (LPS)

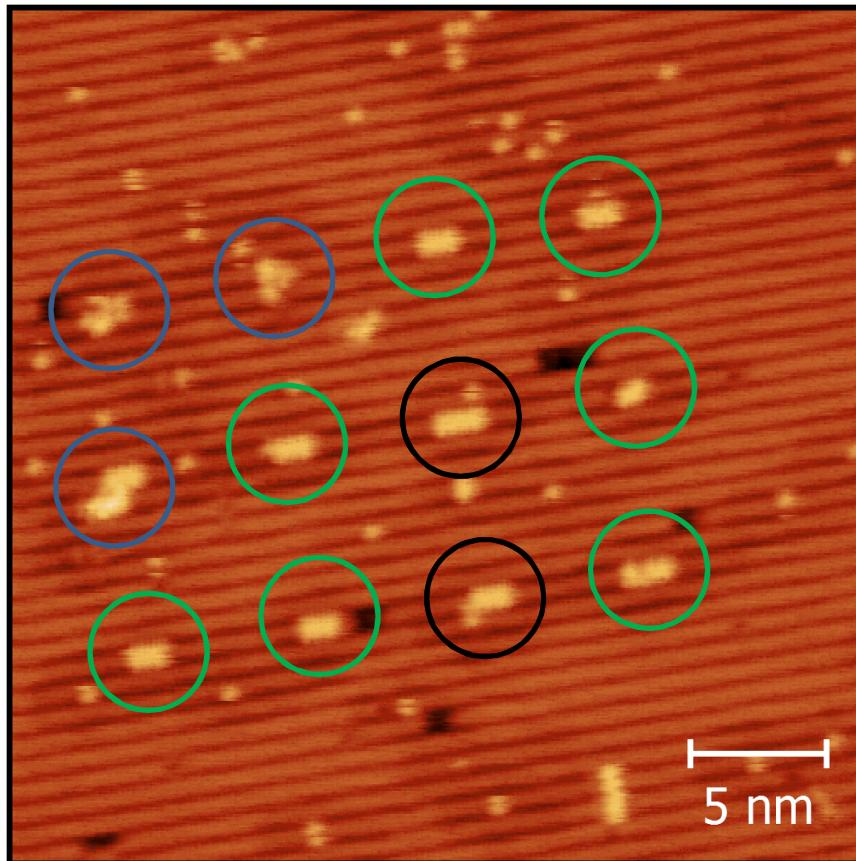
Target Litho Array
Element: 1x3 Dimers



Lithographic Arrays – Better Alignment

Steps to improve litho yield:

- (1) Reduce Array Size to Improve Alignment to Dimer Rows
- (2) Consistent Tip Preparation

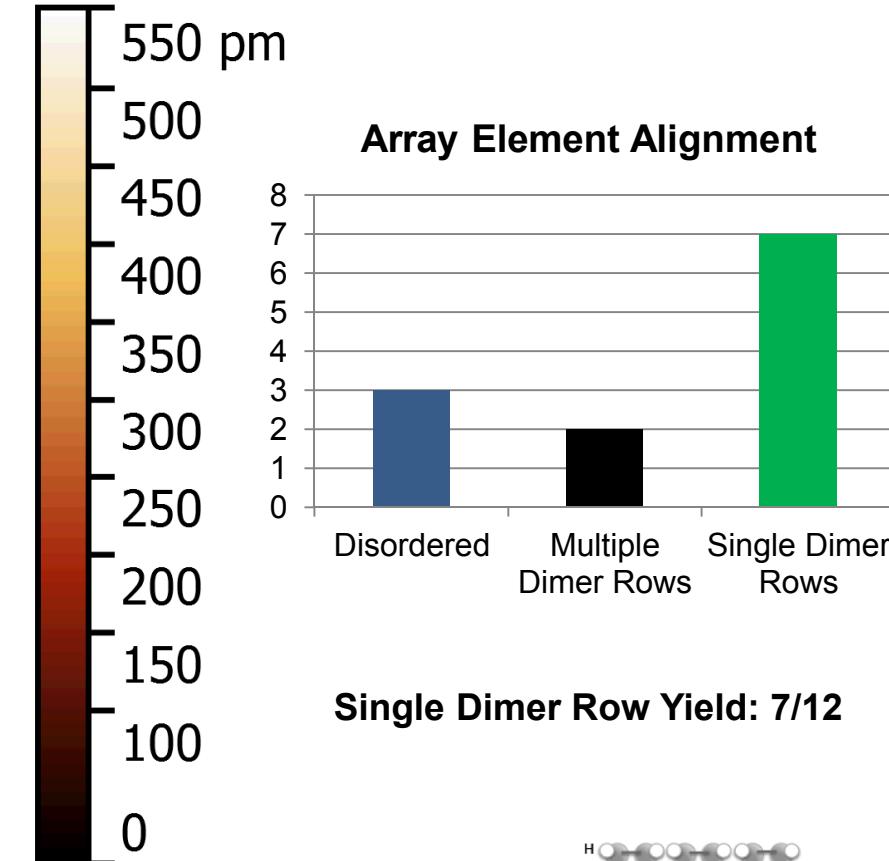


Litho Feature Legend:

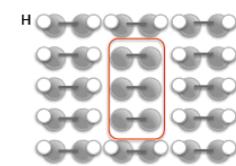
Disordered Features

Multiple Dimer Row Features

Single Dimer Row Features

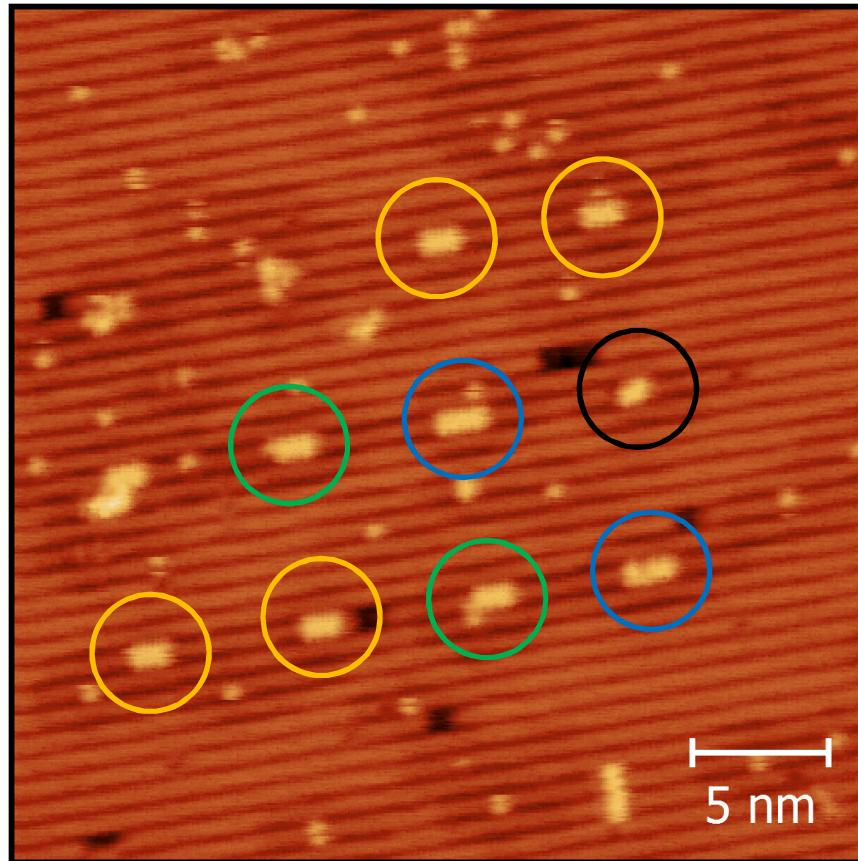


Target Litho Array
Element: 1x3 Dimers



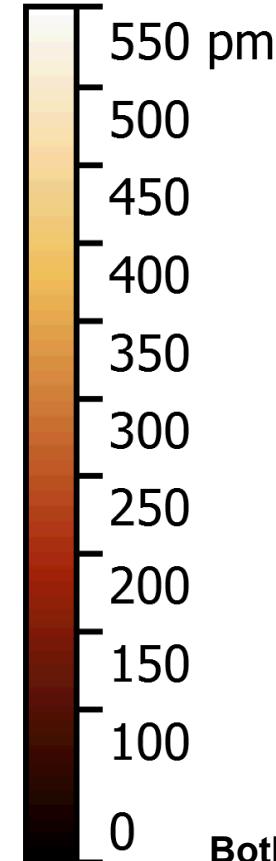
Lithographic Arrays – Better Yield

Reduced Array Size and Consistent Tip Preparation

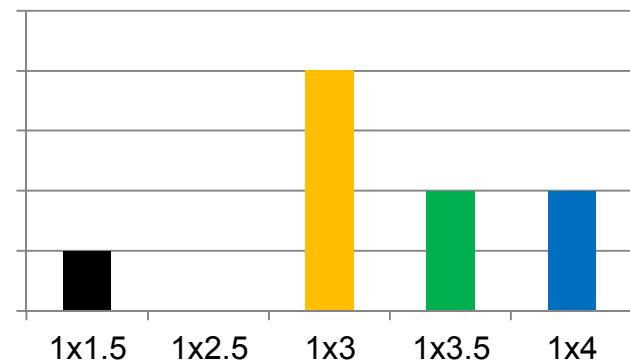


Litho Feature Legend:

1x1.5 Dimers
1x2.5 Dimers
1x3 Dimers
1x3.5 Dimers
1x4 Dimers

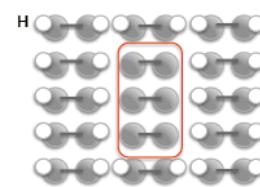


Single Dimer Row Pattern Length (Dimers)



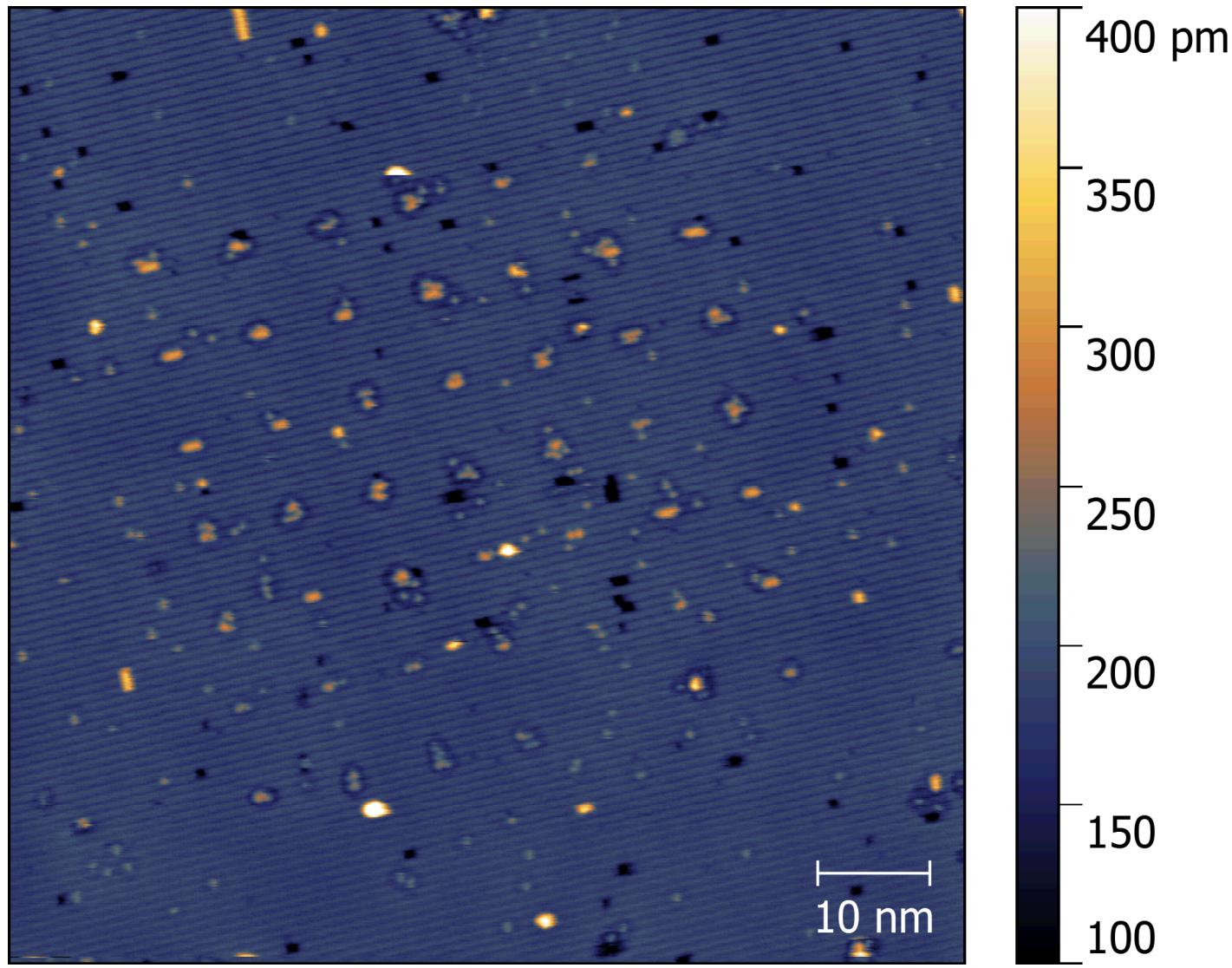
Yield of 1x3 Dimer Patterns: 4/12
Both 1x3 and 1x3.5 Dimer Patterns: 6/12

Target Litho Array
 Element: 1x3 Dimers

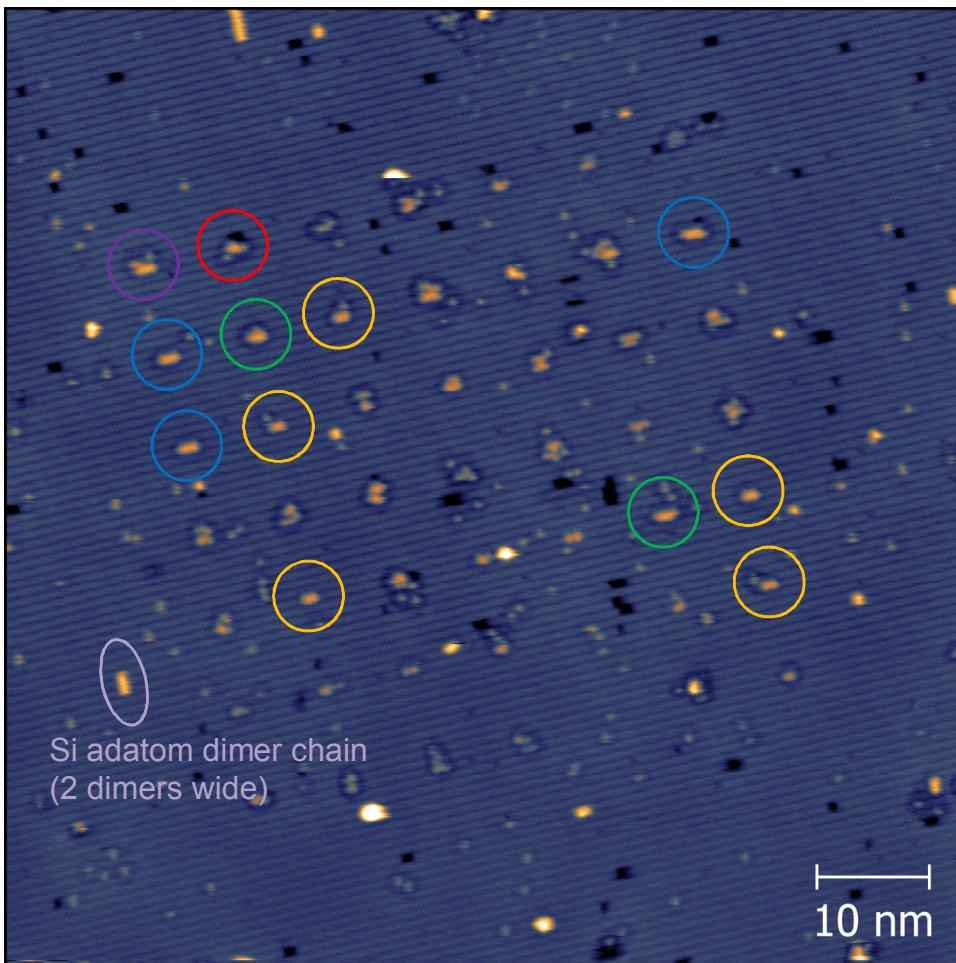


P Donor Incorporation in Lithographic Arrays

7x7 Litho Array



P Donor Incorporation in Lithographic Arrays



1x2.5 Dimers

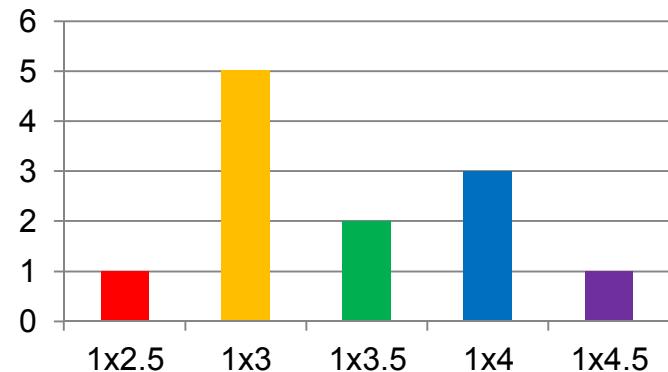
1x3 Dimers

1x3.5 Dimers (extra dangling bond)

1x4 Dimers

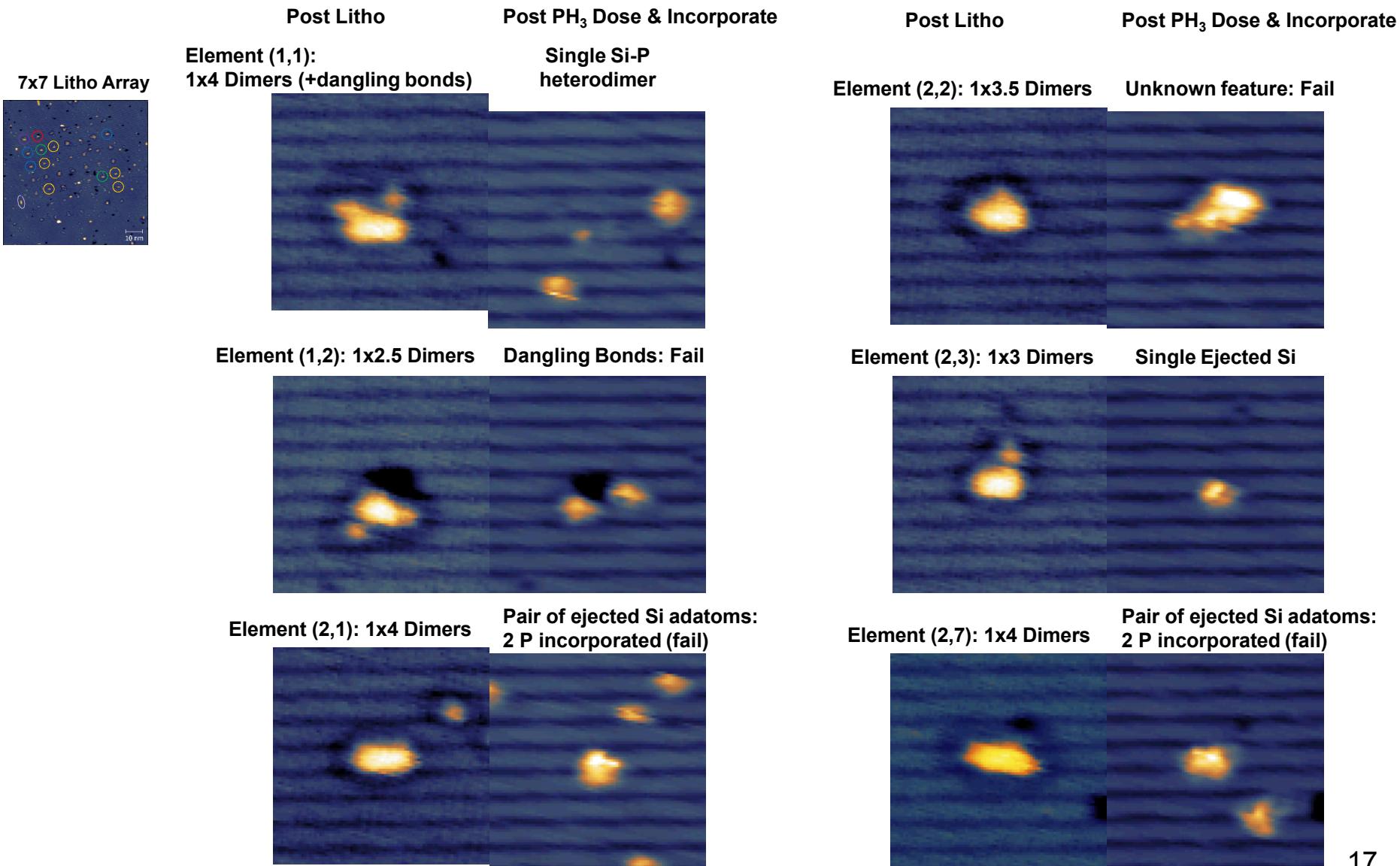
1x4.5 Dimers (extra dangling bonds)

Single Dimer Row Pattern Length (Dimers)

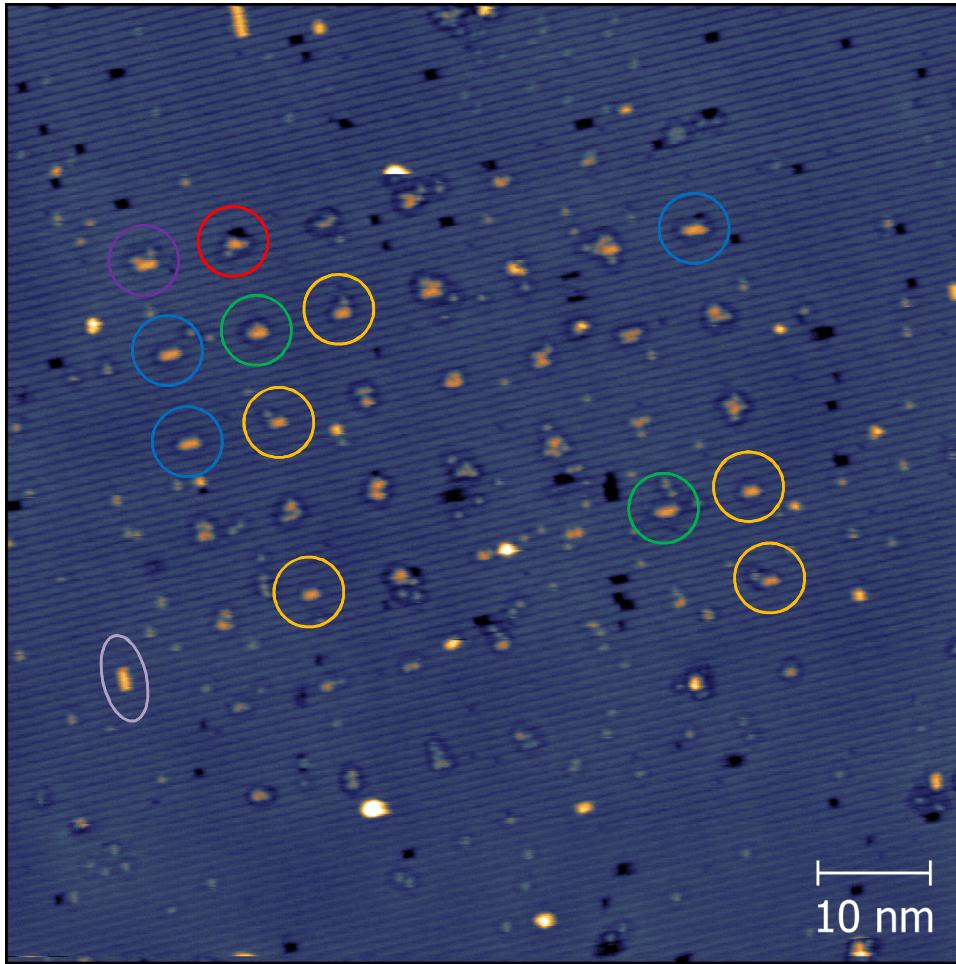


Yield of 1x3 Dimer Patterns: 5/49 (~10%)
Both 1x3 and 1x3.5 Dimer Patterns: 7/49 (~15%)

Analysis of P Donor Incorporation in Arrays



P Donor Yield in Lithographic Arrays



1x2.5 Dimers

1x3 Dimers

1x3.5 Dimers (extra dangling bond)

1x4 Dimers

1x4.5 Dimers (extra dangling bonds)

Incorporation Summary

Single Donor Incorporation:

- (1,1), (2,3), (3,2), (5,6), (5,7)

Double Donor Incorporation:

- (2,1), (2,7), (3,1), (6,7)

Unknown:

- (2,2)

Nothing:

- (1,2), (5,2)

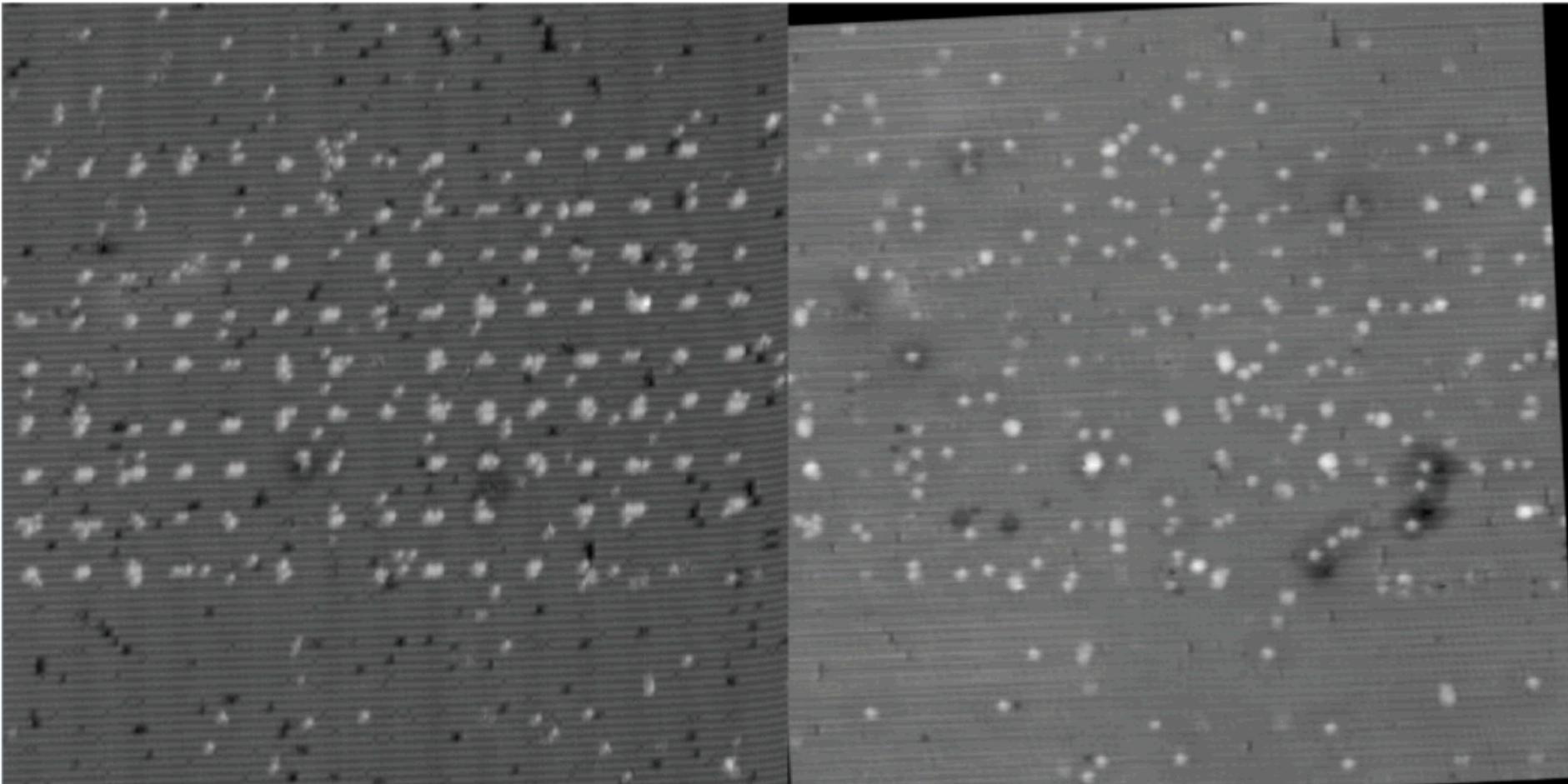
Single P yield for array: ~10% (5/49)

Single P incorporation for only 1x3 dimer sites : 60% (3/5)

Feature Identification for Array Analysis

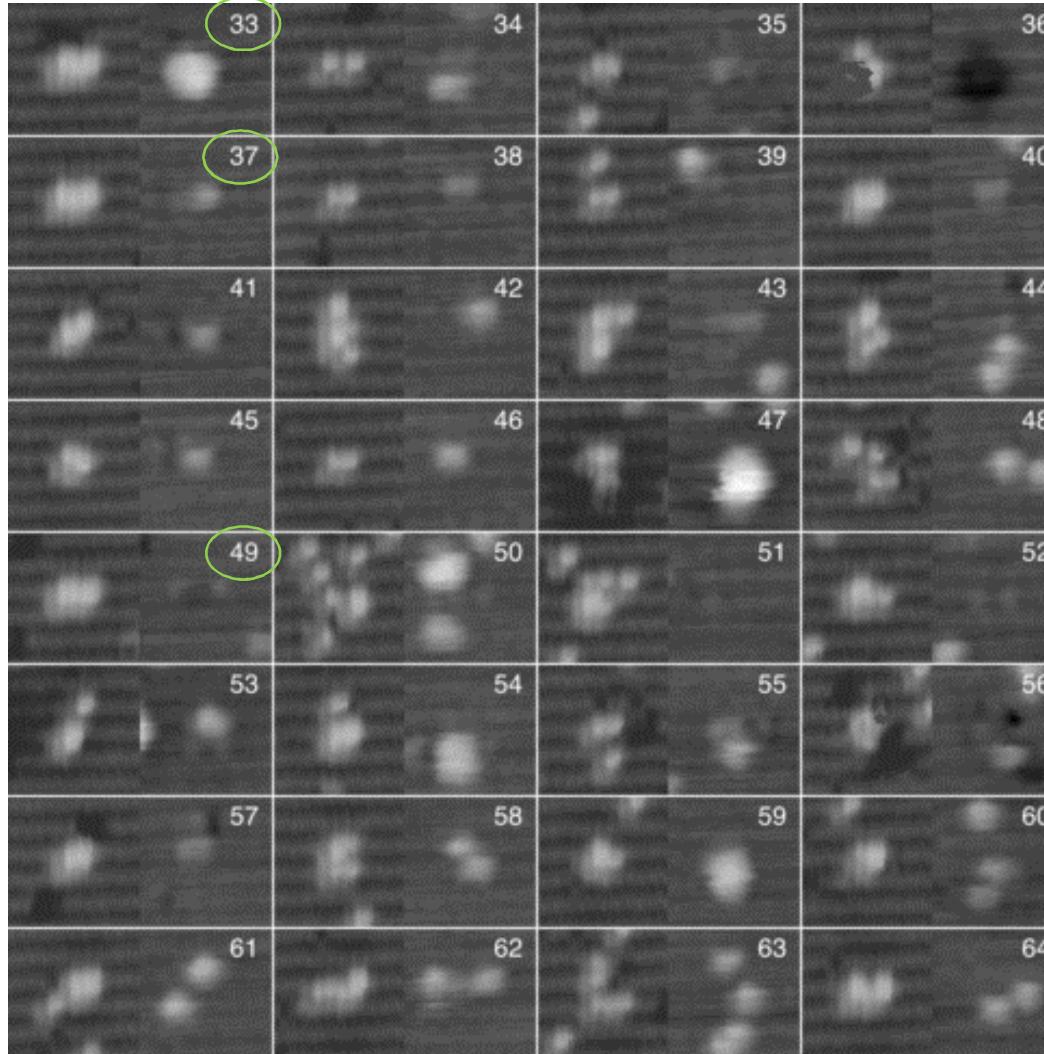
9x15 Lithographic Array, 100 nm x 100 nm

After PH₃ Dose and Incorporation



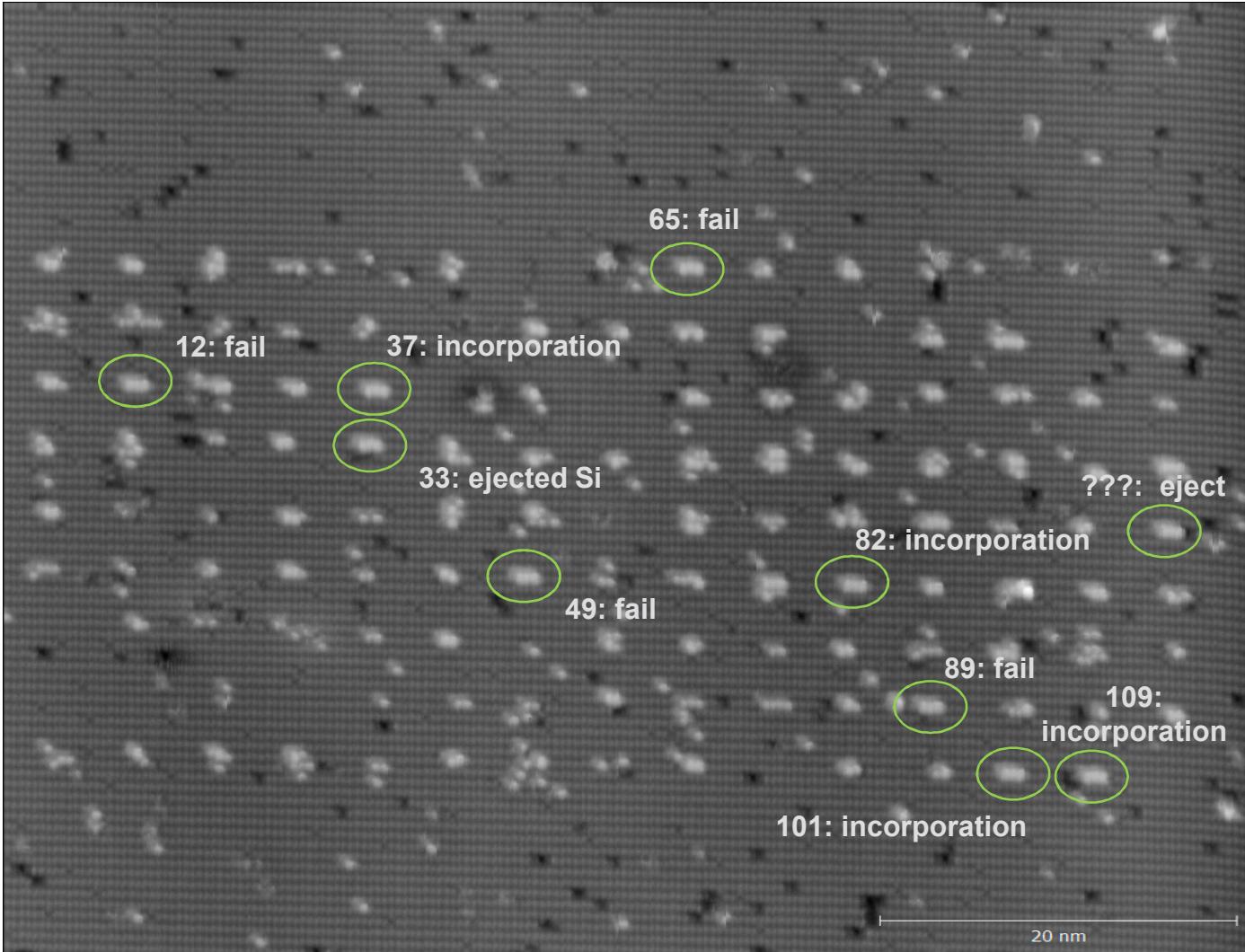
Align scan after lithography and scan after PH₃ dose and incorporation

Feature Identification in Incorporated Arrays



**Compare post-lithography and post PH_3 dose and incorporation.
Did P incorporation happen at the litho sites?**

P Donor Yield in Lithographic Arrays



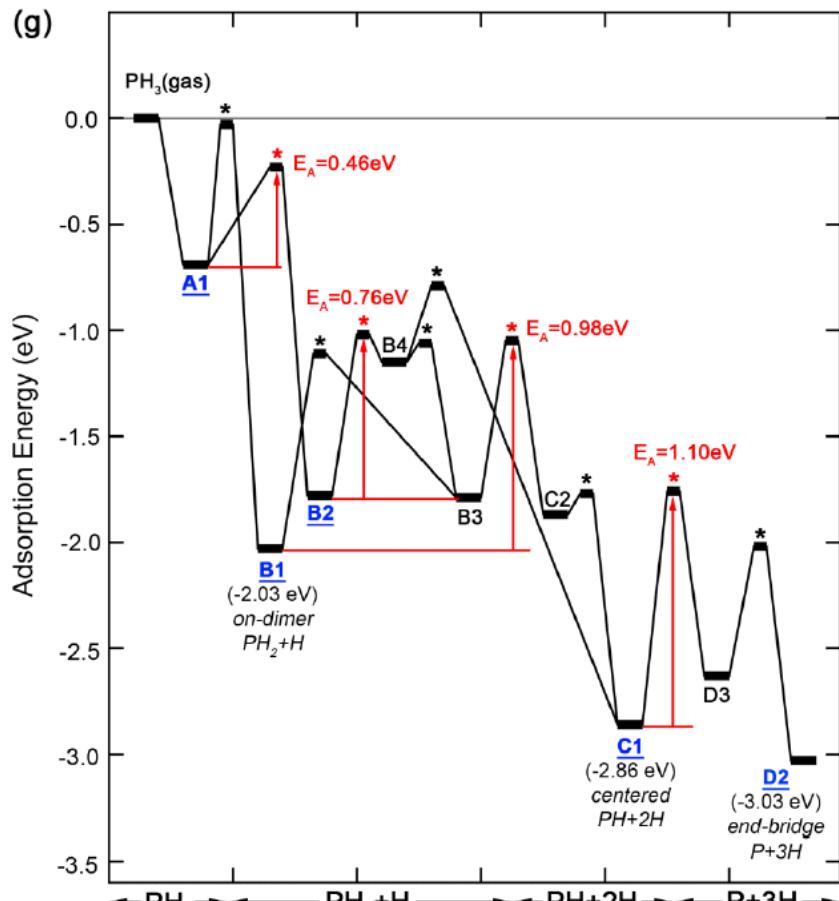
9x15 Litho Array. 10 out of 135 (7%) sites successful 1x3 dimer patches.

7 incorporated 1x3 dimer litho sites out of 135: 5% single donor yield for array.

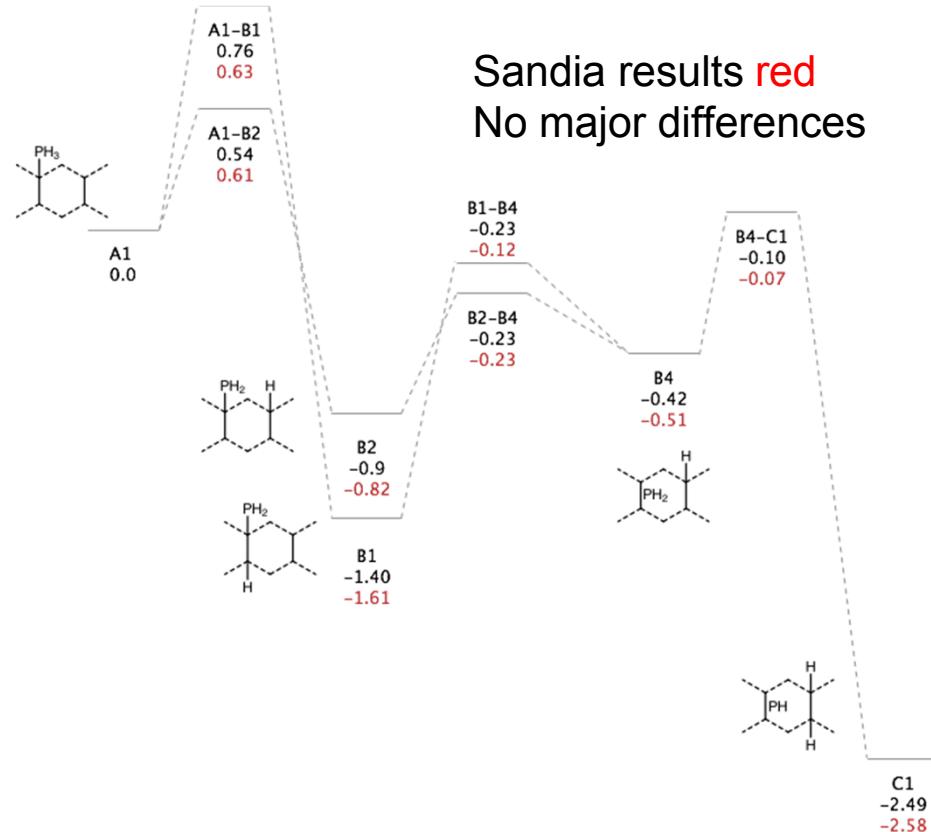
7 incorporated sites out of 10 1x3 dimer litho sites: 70% incorporation in 1x3 dimer patches. 21

Simulations of P Donor Incorporation

Calculated PH_3 Dissociation Reaction Barriers



Warschekow, J. Chem. Phys., 144 (2016)

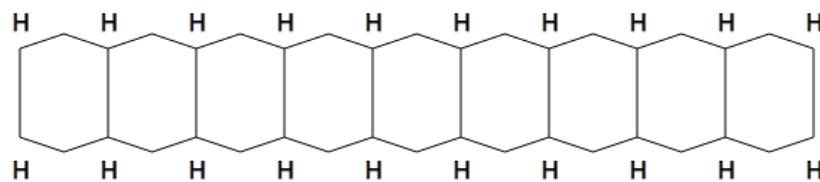


Muller, Schultz, Baczewski (Sandia)

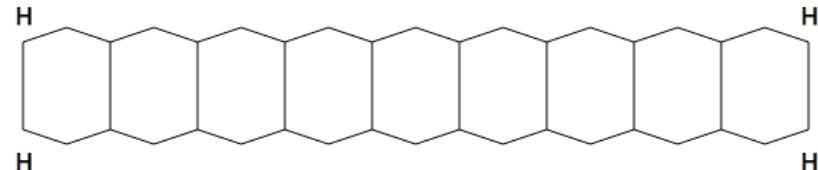
Kinetic Monte Carlo Simulations of P Incorporation

KMC is an algorithm to rapidly sample a chemical mechanism to generate probable resulting product states.

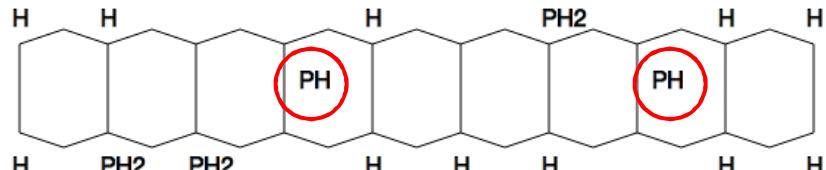
Create a row of N dimers (here N=10)



Depassivate the interior dimers

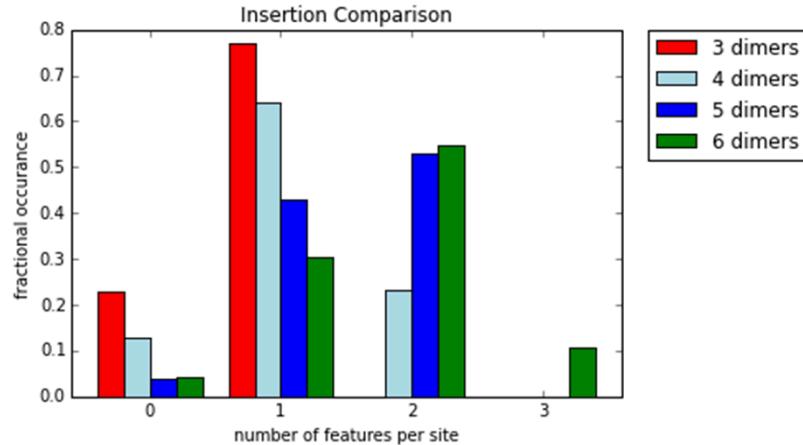
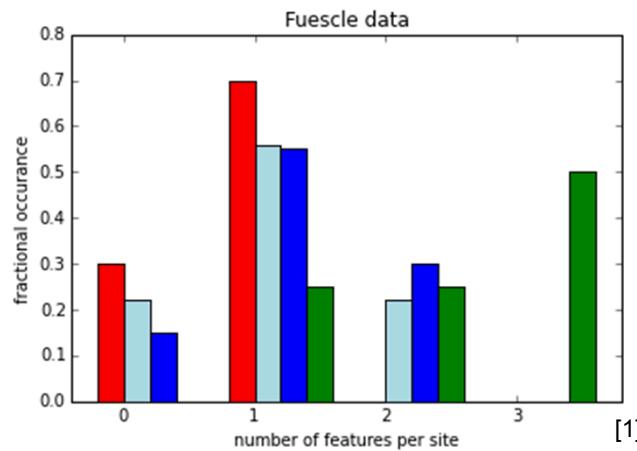


Sample the chemistry until the surface is saturated



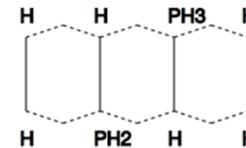
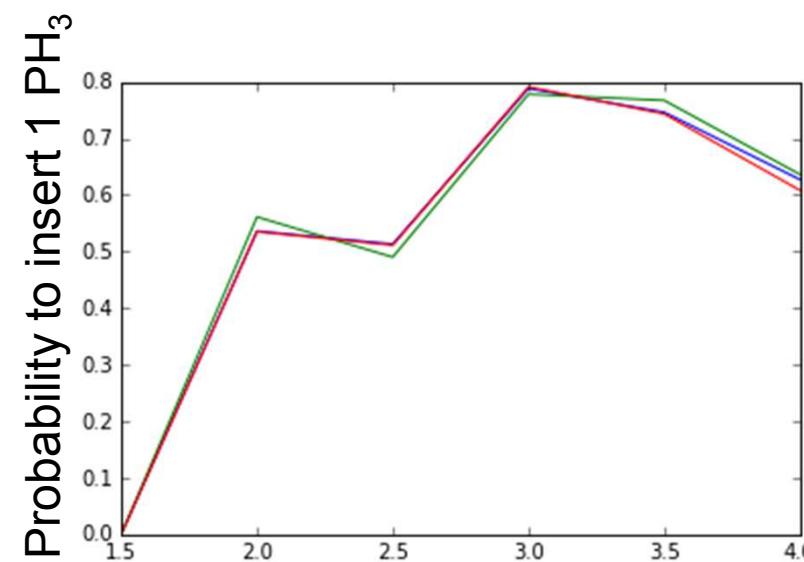
Bridging PH groups lead to P incorporation

Kinetic Monte Carlo Simulations of P Incorporation in Lithographic Windows

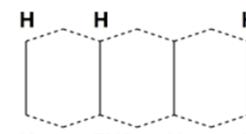


Values for 1x3 dimer lithographic windows
similar to our experimental values (0.6 – 0.7).

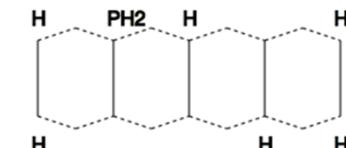
[1] Fuechsle, *Ph.D. Dissertation* (2011)



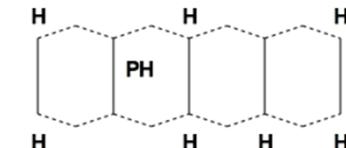
$t=0.411$



$t=0.707$



$t=0.040$



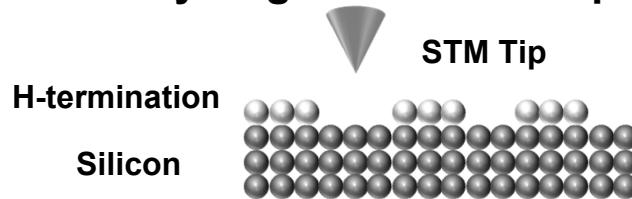
Summary

- Demonstrated STM Hydrogen Lithography at length scales necessary for placing single P donors
- Yield of 1x3 dimer patterns initially 0%.
- Increased yield to 10% in large arrays with better tip alignment.
- Better tip alignment for small arrays led to 1x3 dimer pattern yield up to 33%.
- Overall yield of single P donors for Arrays ~5-10%.
- Yield of single P donors only for 1x3 dimer features ~60% – 70%, very close to simulation values and prior experimental data.

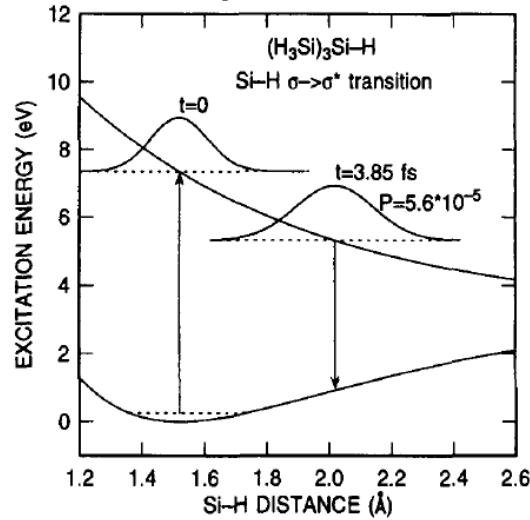
Extra Information

STM Hydrogen Lithography Mechanisms

Remove Hydrogen with STM Tip



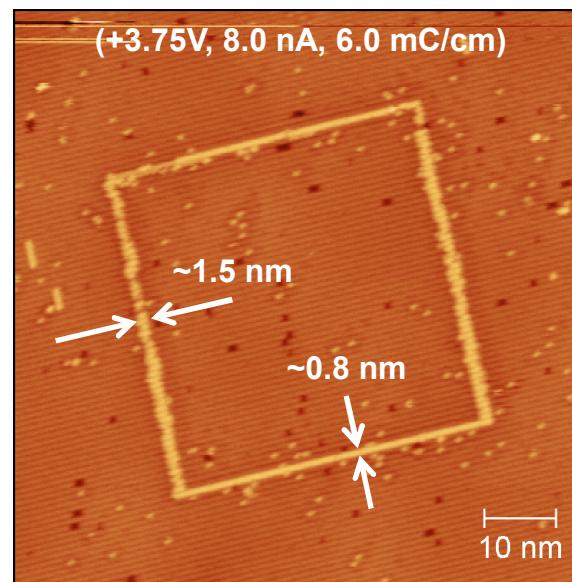
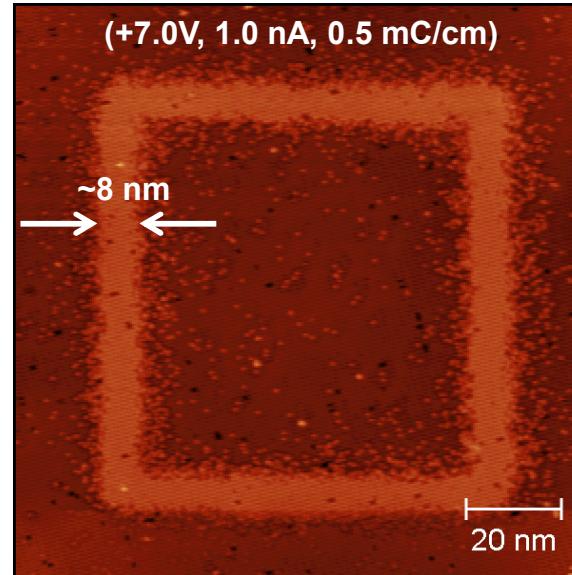
Two H Desorption Mechanisms



Avouris, *Chem. Phys. Lett.*, 257 (1996)

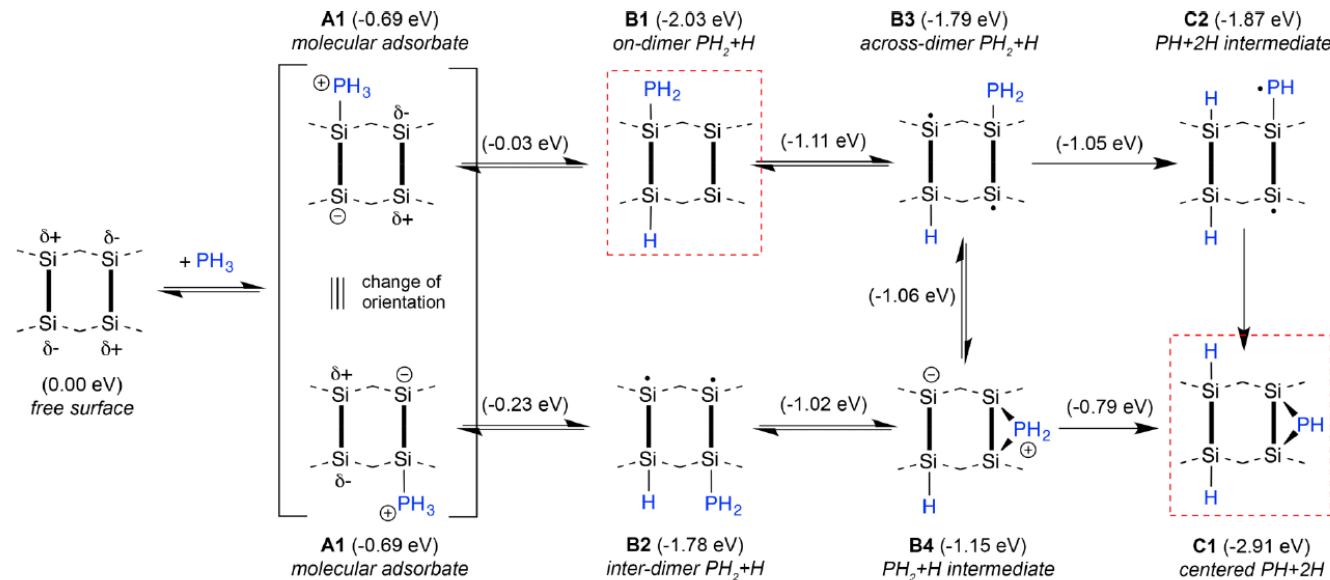
Multi-electron stochastic process

Tune pattern size with (V, I, dose) conditions



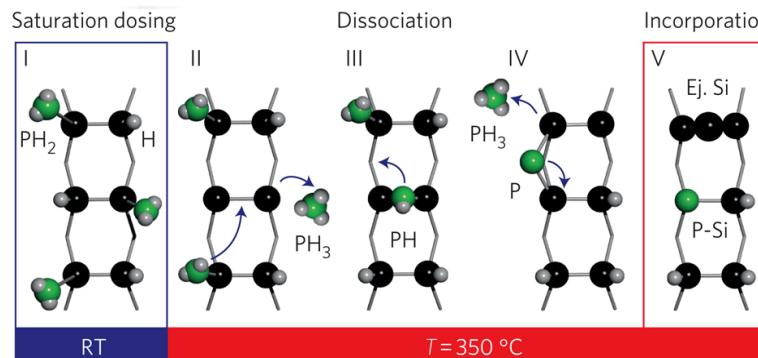
P Donor Incorporation Mechanism

Adsorption and Dissociation of PH₃ on Si(100)



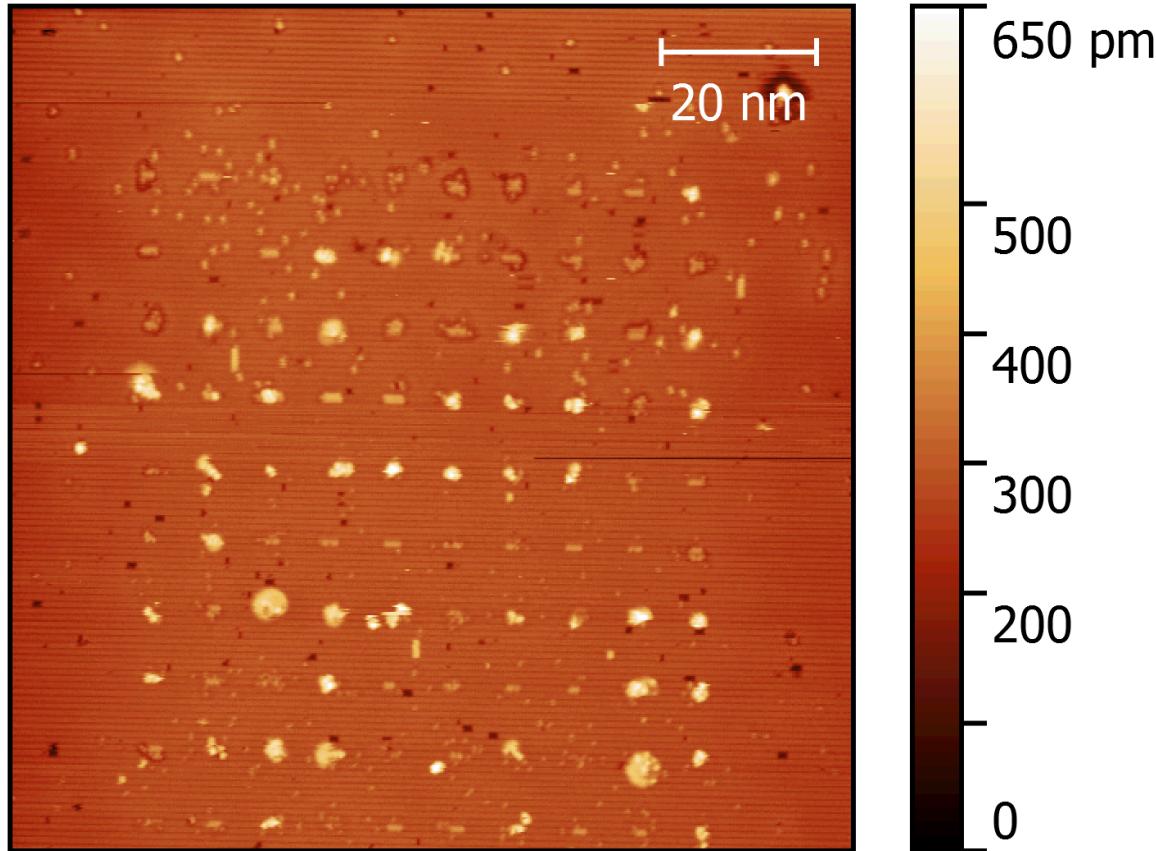
Warschkow, *J. Chem. Phys.*, 144 (2016)

Route to single P donor incorporation



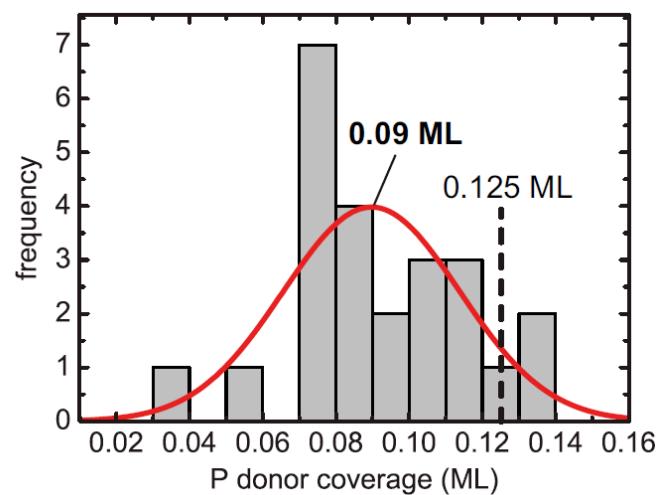
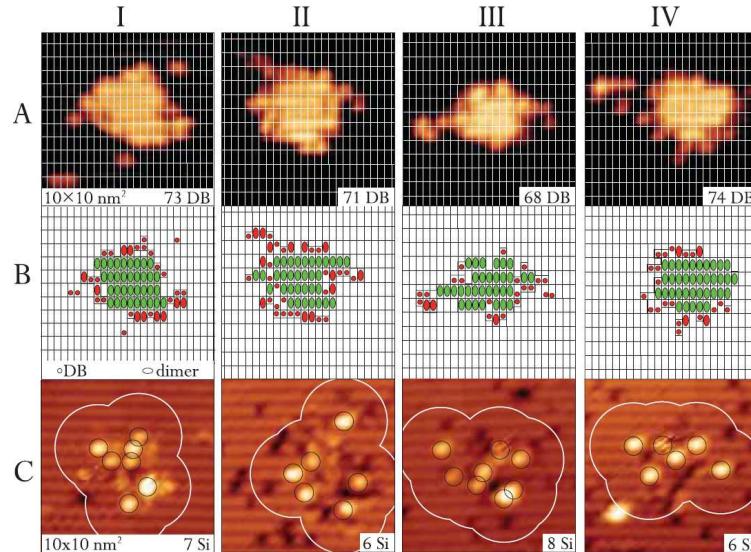
Fuechsle, *Nat. Nano.*, 7 (2012)

Lithographic Arrays – Tip Limitations

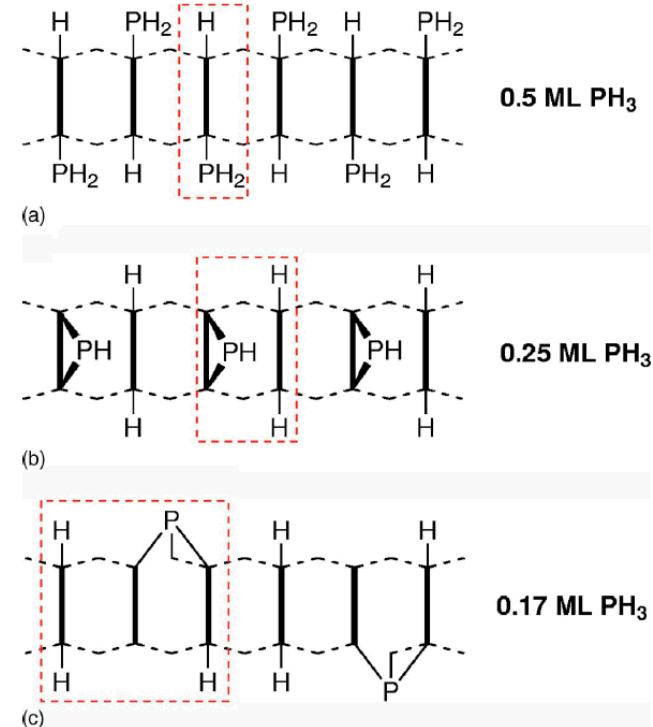


Tip limitations: drops material, apex changes leading to misalignment, apex modifications alter conditions for successful writing.

Donor Yield in Small Lithographic Boxes



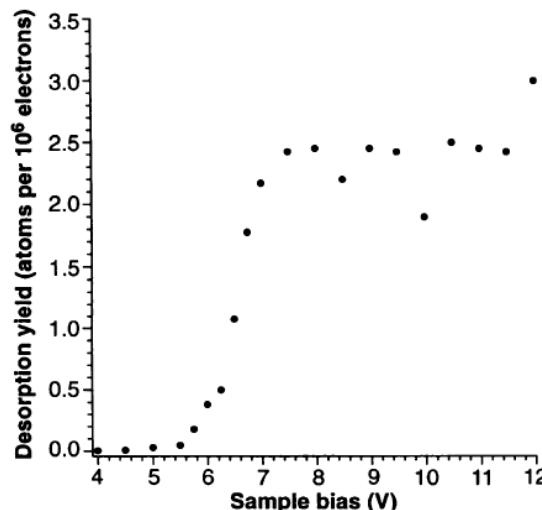
Fuechsle, *Ph.D. Dissertation* (2011)



Wilson, *Phys. Rev. B*, 74 (2006)

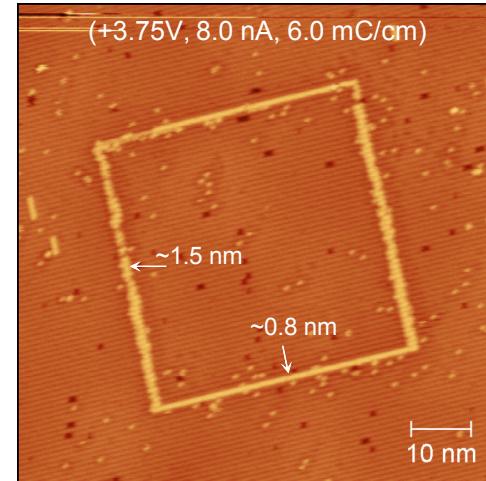
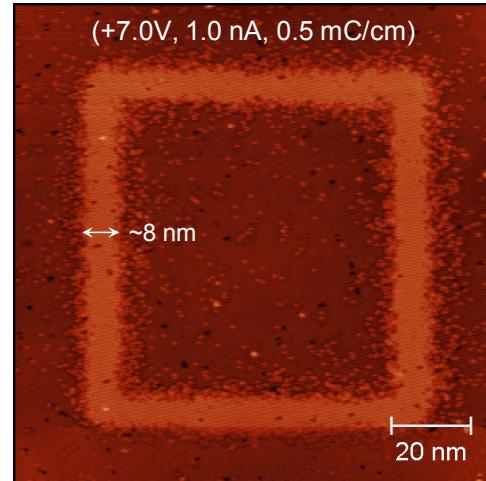
STM Hydrogen Lithography Mechanisms

Bias/Current Dependence of H Desorption Yield

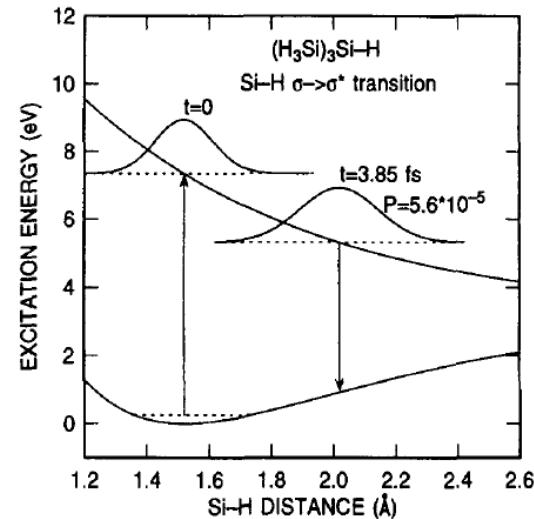


Shen, *Science*, 268 (1995)

Two Patterning Fidelity Regimes



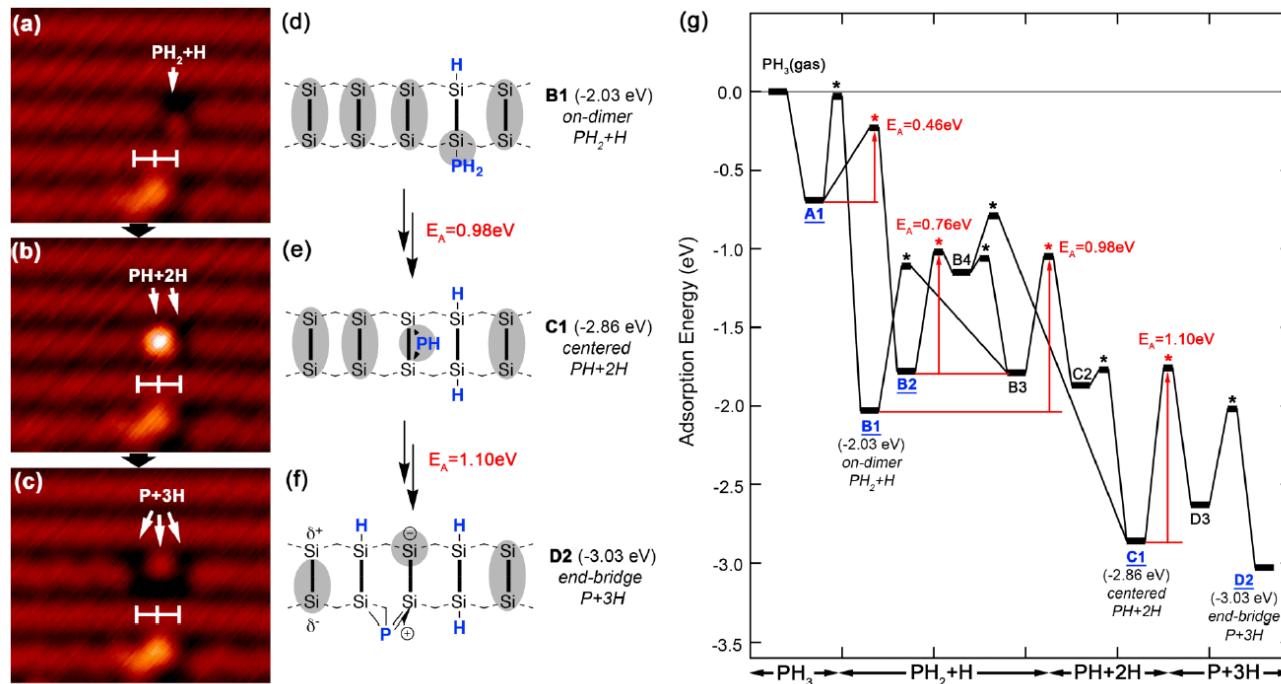
Two H Desorption Mechanisms



Avouris, *Chem. Phys. Lett.*, 257 (1996)

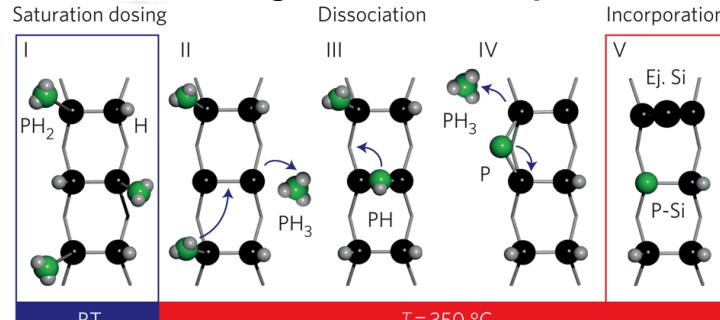
P Donor Incorporation Mechanism

Adsorption and Dissociation of PH₃ on Si(100)



Warschkow, *J. Chem. Phys.*, 144 (2016)

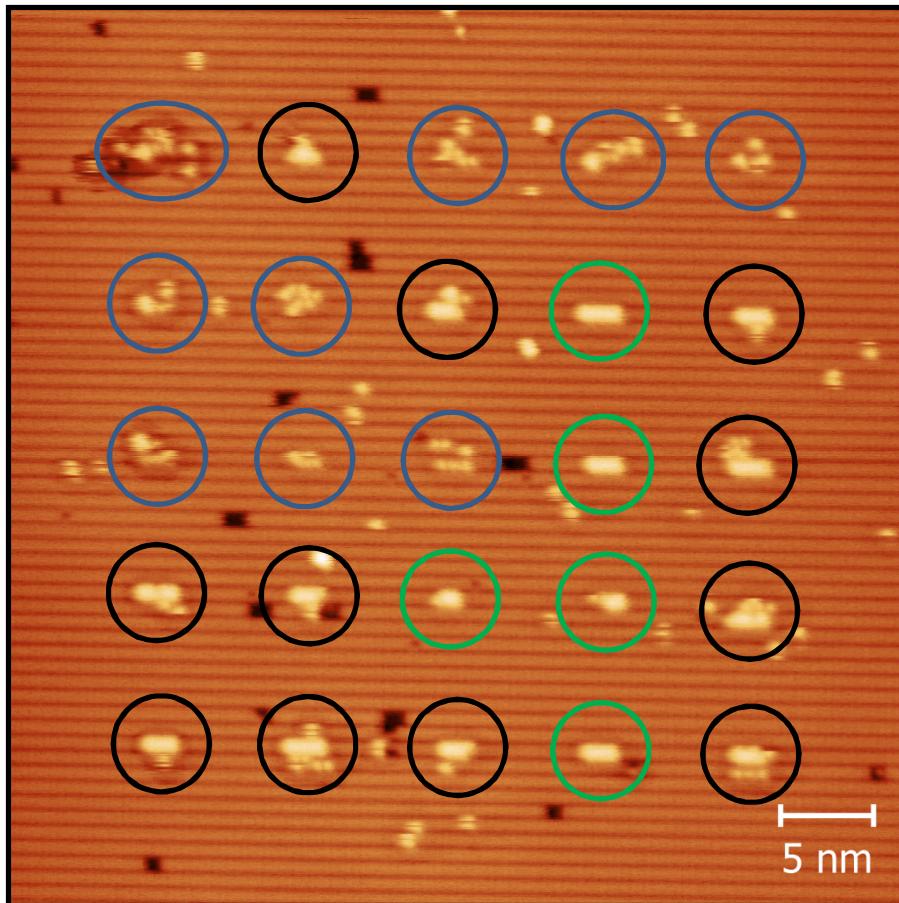
Route to single P donor incorporation



Fuechsle, *Nat. Nano.*, 7 (2012)

Lithographic Arrays – Alignment

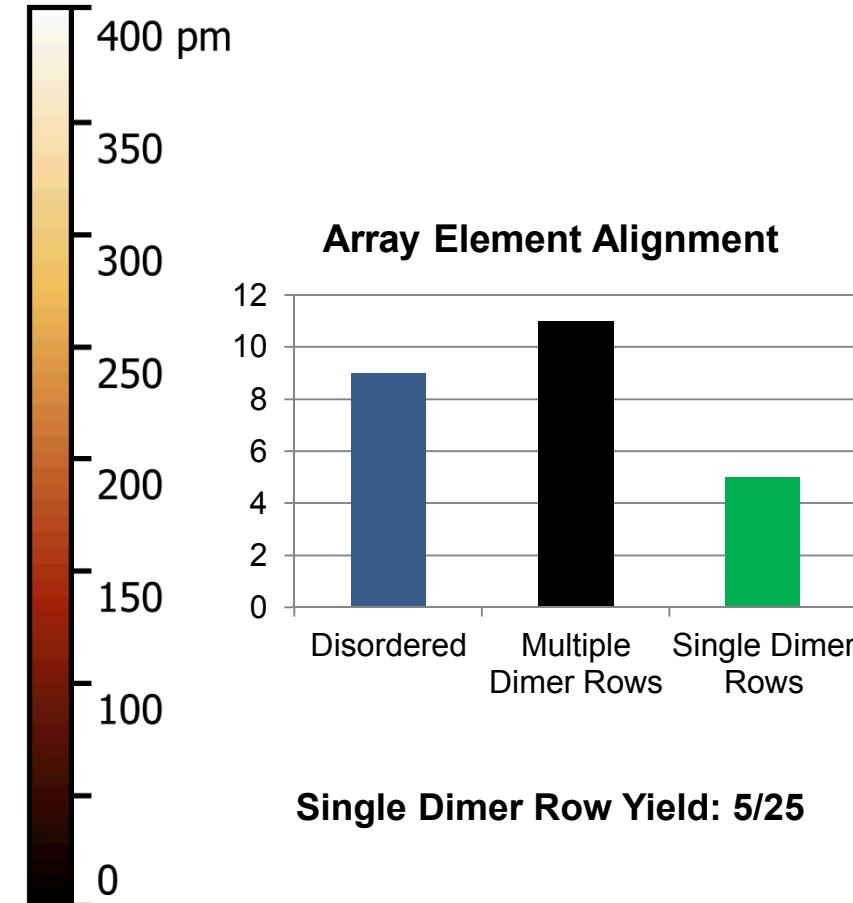
5x5 Litho Array Litho Parameters:
(+2.75 V, 15.0 nA, 10.0 mC/cm, 15 nm/s)



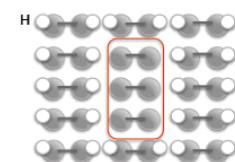
Disordered Features

Multiple Dimer Row Features

Single Dimer Row Features

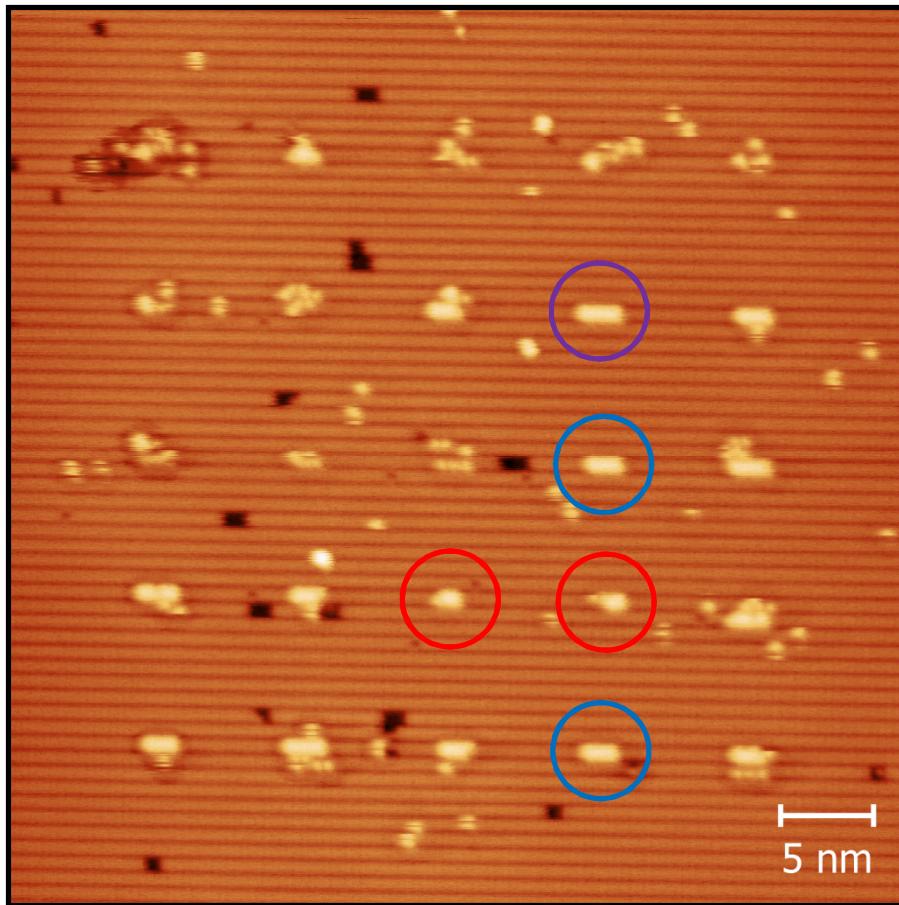


Target Litho Array
Element: 1x3 Dimers

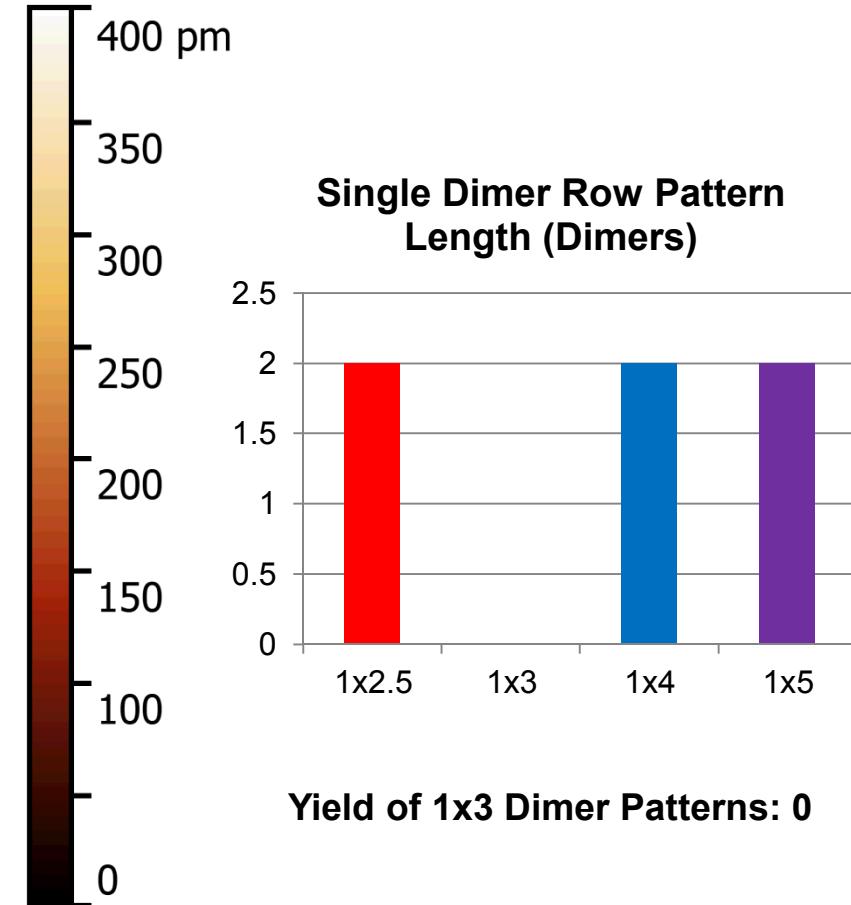


Lithographic Arrays – Pattern Length

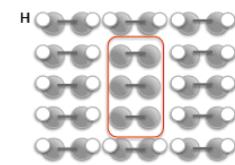
5x5 Litho Array Litho Parameters:
(+2.75 V, 15.0 nA, 10.0 mC/cm, 15 nm/s)



1x2.5 Dimers
 1x3 Dimers
 1x4 Dimers
 1x5 Dimers



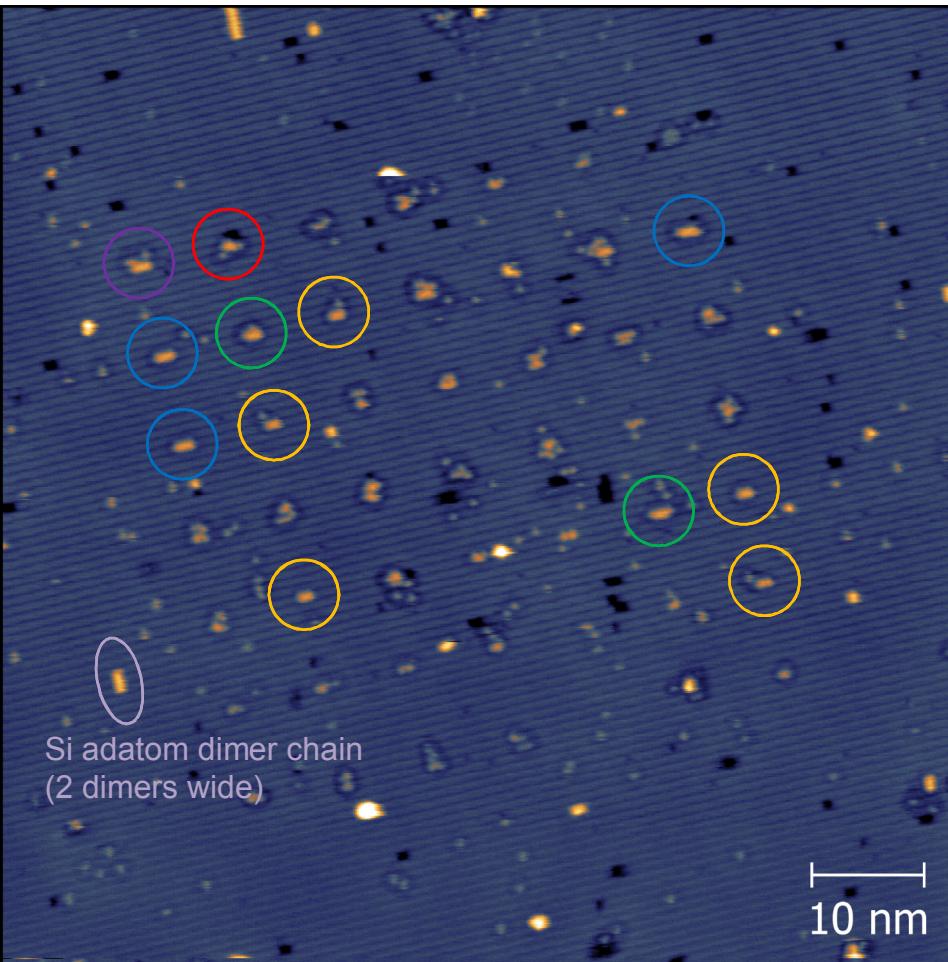
Target Litho Array Element: 1x3 Dimers



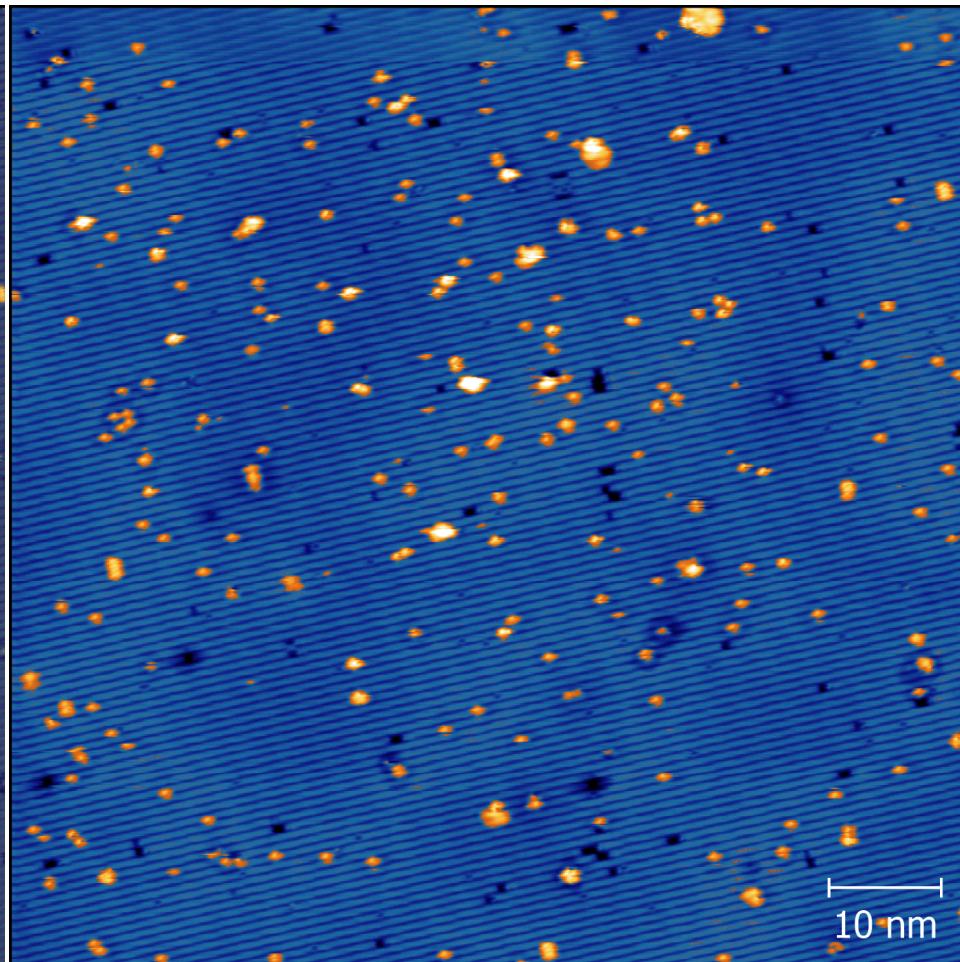
P Donor Incorporation in Lithographic Arrays



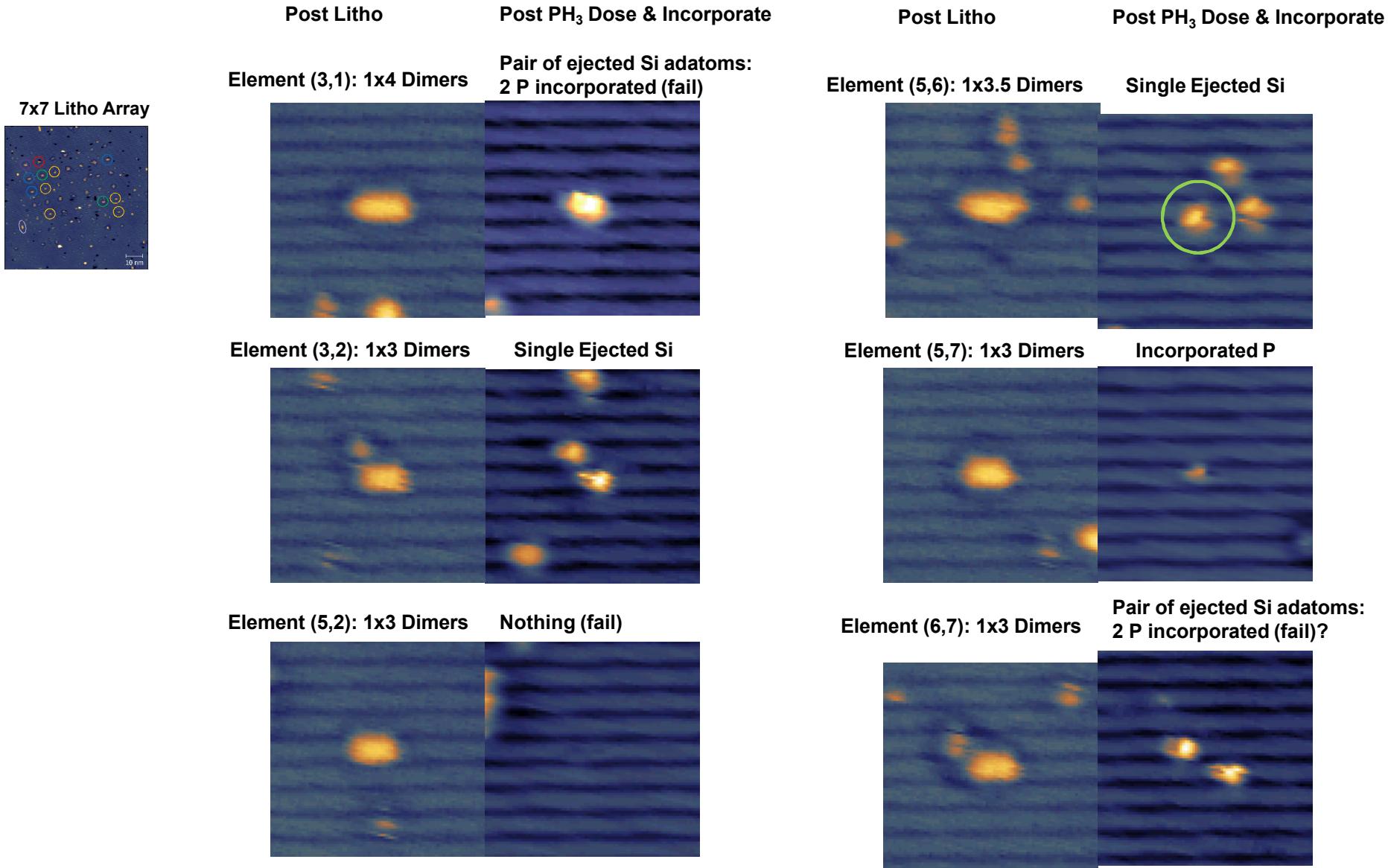
7x7 Lithographic Array



After PH₃ Dose and Incorporation

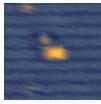


P Donor Incorporation in Lithographic Arrays

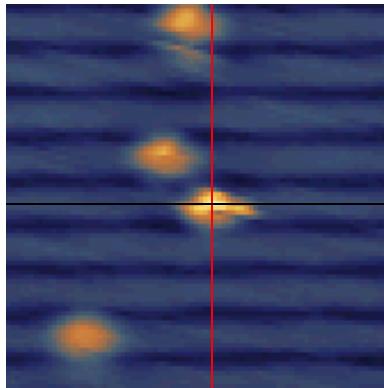


P Donor Incorporation in Lithographic Arrays

Post Litho, Pre-PH₃

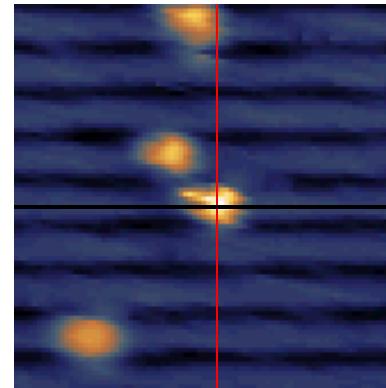


Post-PH₃ Incorporation (filled states), trace

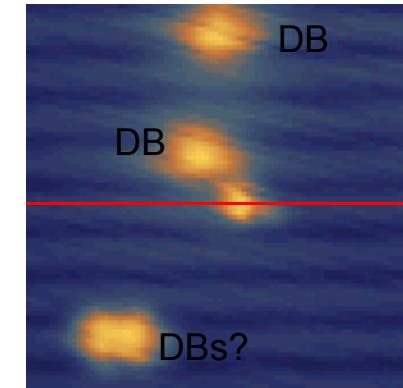


Array Element (3,2) – 1x3 dimers

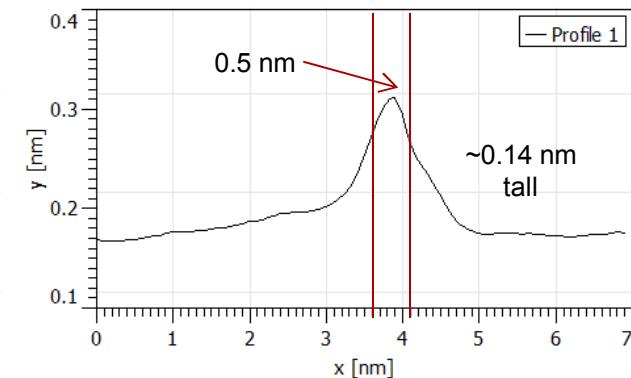
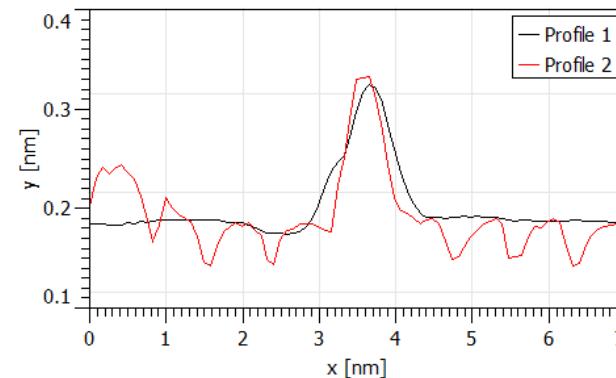
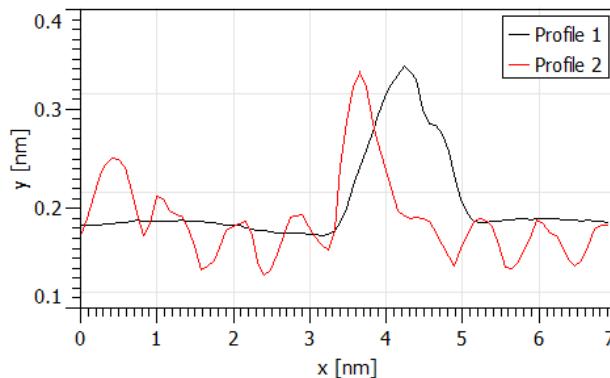
Post-PH₃ Incorporation (filled states), re-trace



Post-PH₃ Incorporation (empty states)



Single ejected Si atom



Along dimer row cross section:

~0.165 nm tall and ~0.67 nm wide

Across dimer row cross section:

~0.166 nm tall and ~0.39 nm wide

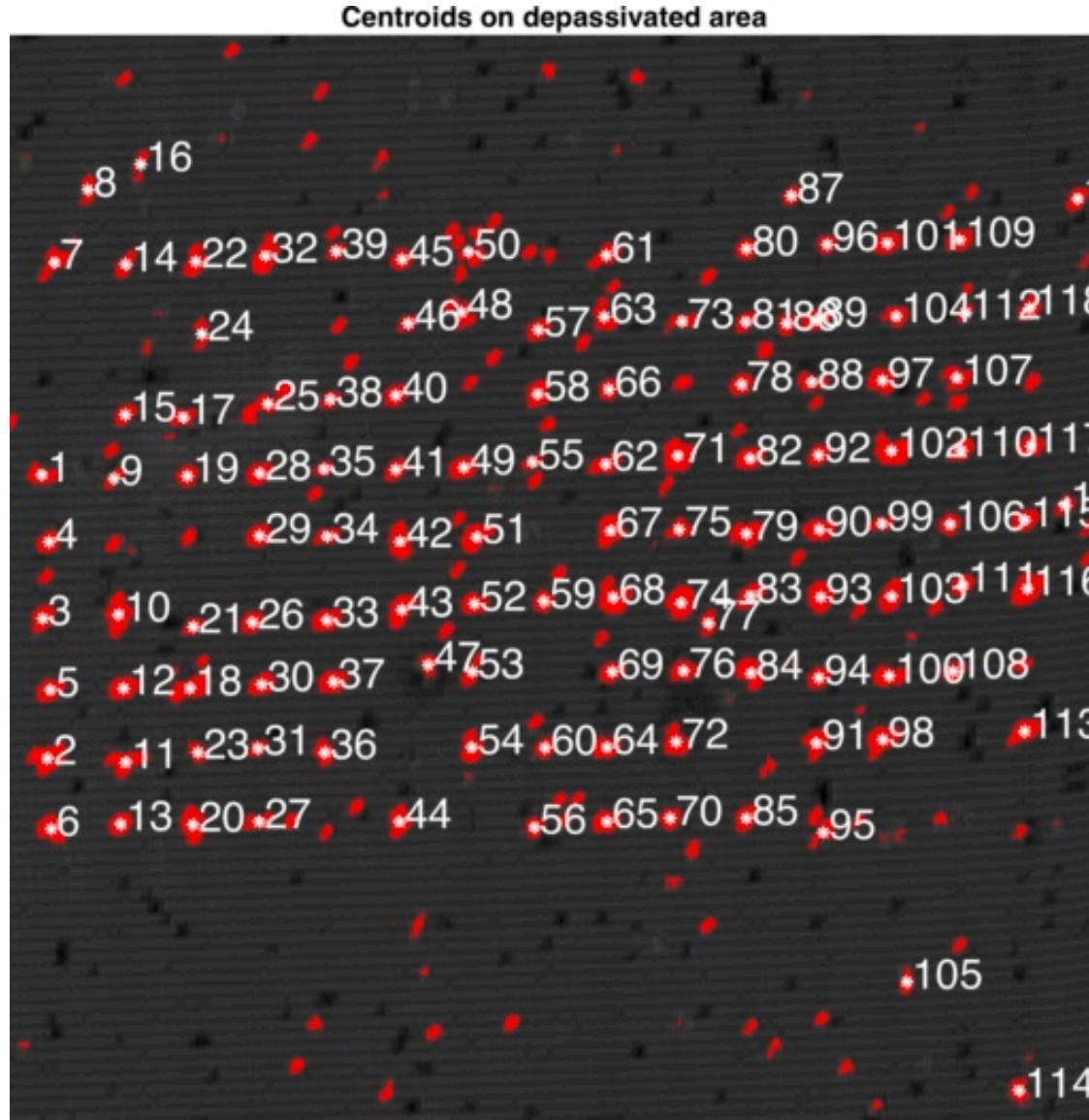
Along dimer row cross section:

~0.150 nm tall and ~0.51 nm wide

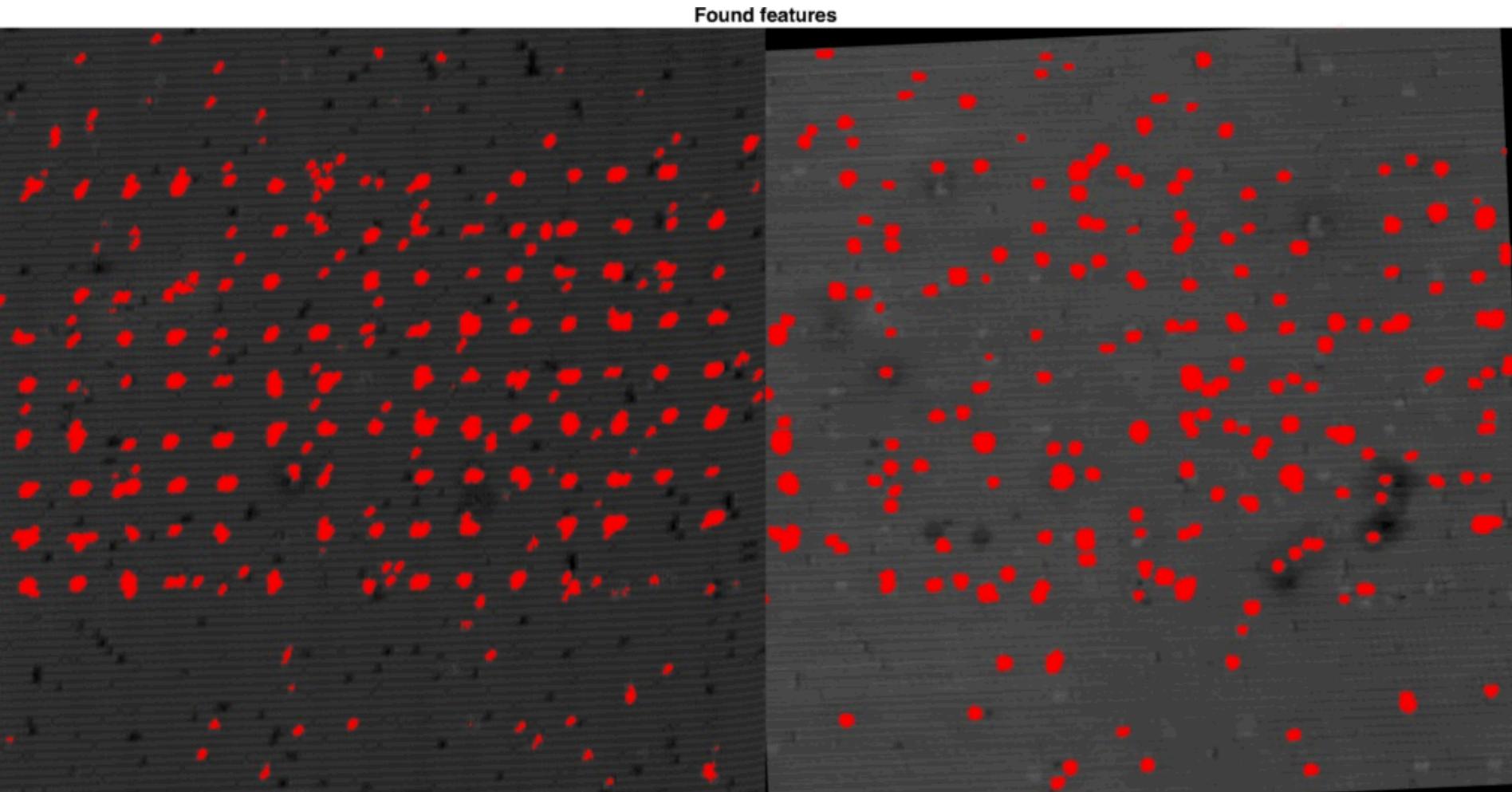
Across dimer row cross section:

~0.169 nm tall and ~0.46 nm wide

Feature Identification for Array Analysis

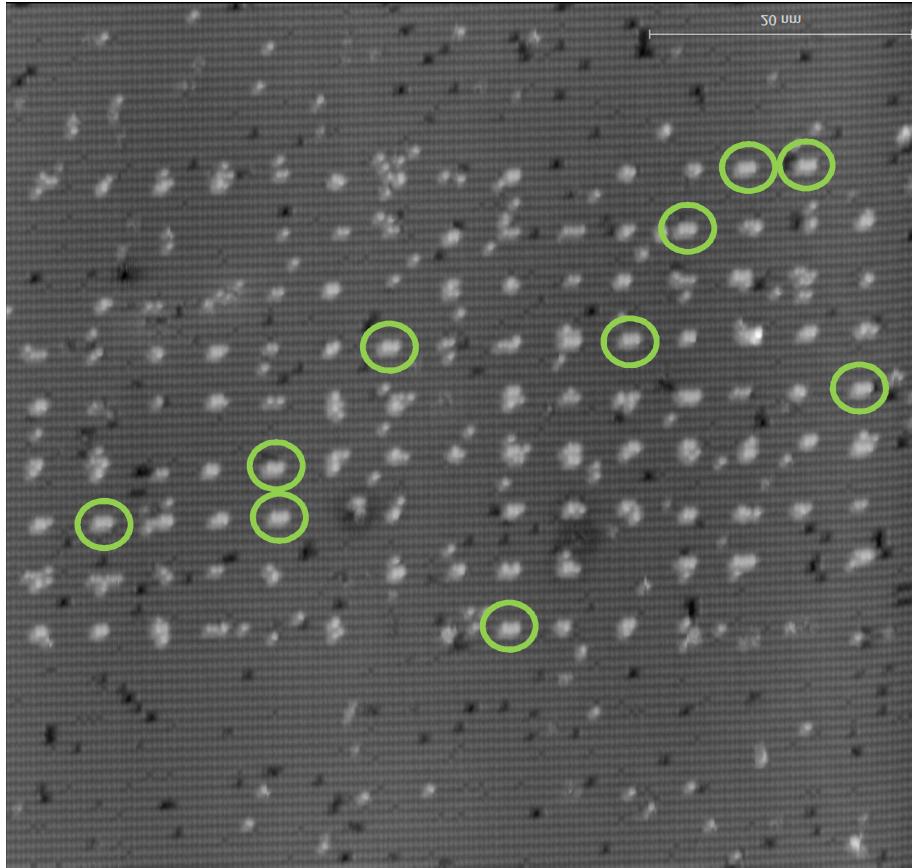


Feature Identification for Array Analysis

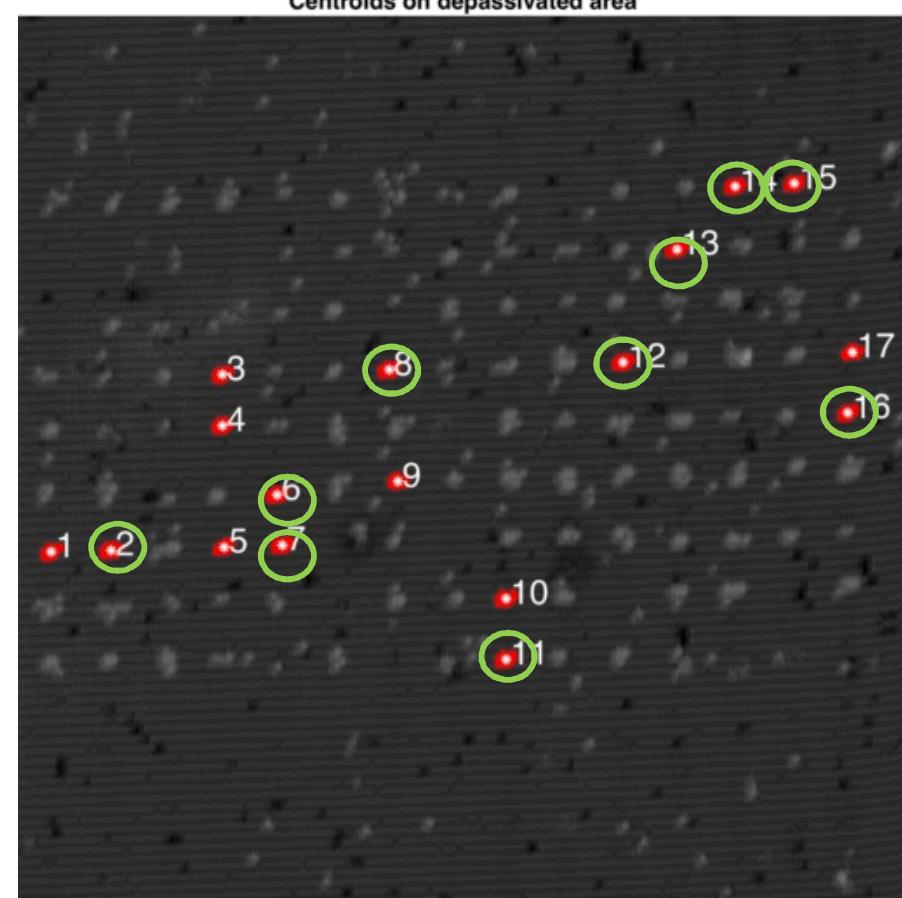


Feature Identification for Array Analysis

Now refind regions using data from successes (minor/major axis + area)



10 areas



All 10 real area / Total of 17 areas